

LM48901 Boomer® Audio Power Amplifier Series Quad Class D Spatial Array

Check for Samples: [LM48901](#)

FEATURES

- Spatial Sound Processing
- I²S Compatible Input
- Differential-Input Stereo ADC
- Edge Rate Control Reduces EMI while Preserving Audio Quality and Efficiency
- Paralleled Output Mode
- Short Circuit and Thermal Overload Protection
- Minimum external components
- Click and Pop suppression
- Micro-power shutdown

- Available in space-saving micro SMD and LLP packages

APPLICATIONS

- Laptops
- Tablets
- Desktop Computers
- Sound Bars
- Multimedia Devices
- MP3 Player Accessories
- Docking Stations

DESCRIPTION

The LM48901 is a quad Class D amplifier that utilizes Texas Instruments' proprietary spatial sound processor to create an enhanced sound stage for portable multimedia devices. The Class D output stages feature Texas Instruments' edge rate control (ERC) PWM architecture that significantly reduces RF emissions while preserving audio quality and efficiency.

The LM48901's flexible I²S interface is compatible with standard serial audio interfaces. A stereo differential-input ADC gives the device the ability to process analog stereo audio signals.

The LM48901 is configured through an I²C compatible interface and is capable of delivering 2.8W/channel of continuous output power into an 4Ω load with less than 10% THD+N. A 2.1 mode pairs two output drivers in parallel, increasing current drive for 4Ω loads.

Output short circuit and thermal overload protection prevent the device from being damaged during fault conditions. Superior click and pop suppression eliminates audible transients on power-up/down and during shutdown. The LM48901 is available in space saving microSMD and LLP packages.

Table 1. Key Specifications

| | VALUE | UNIT |
|---|---------------------------------|-----------|
| SNR (A-Weighted) | 87 | dBA (typ) |
| Output Power/channel, PV _{DD} = 5V | R _L = 8Ω, THD+N ≤10% | 1.7 |
| | R _L = 4Ω, THD+N ≤10% | 2.8 |
| THD+N | 0.06% (typ) | |
| Efficiency/Channel | 89% (typ) | |
| PSRR at 217Hz | 71 | dB (typ) |
| Shutdown current 1 μA (typ) | 1 | μA (typ) |



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Typical Application

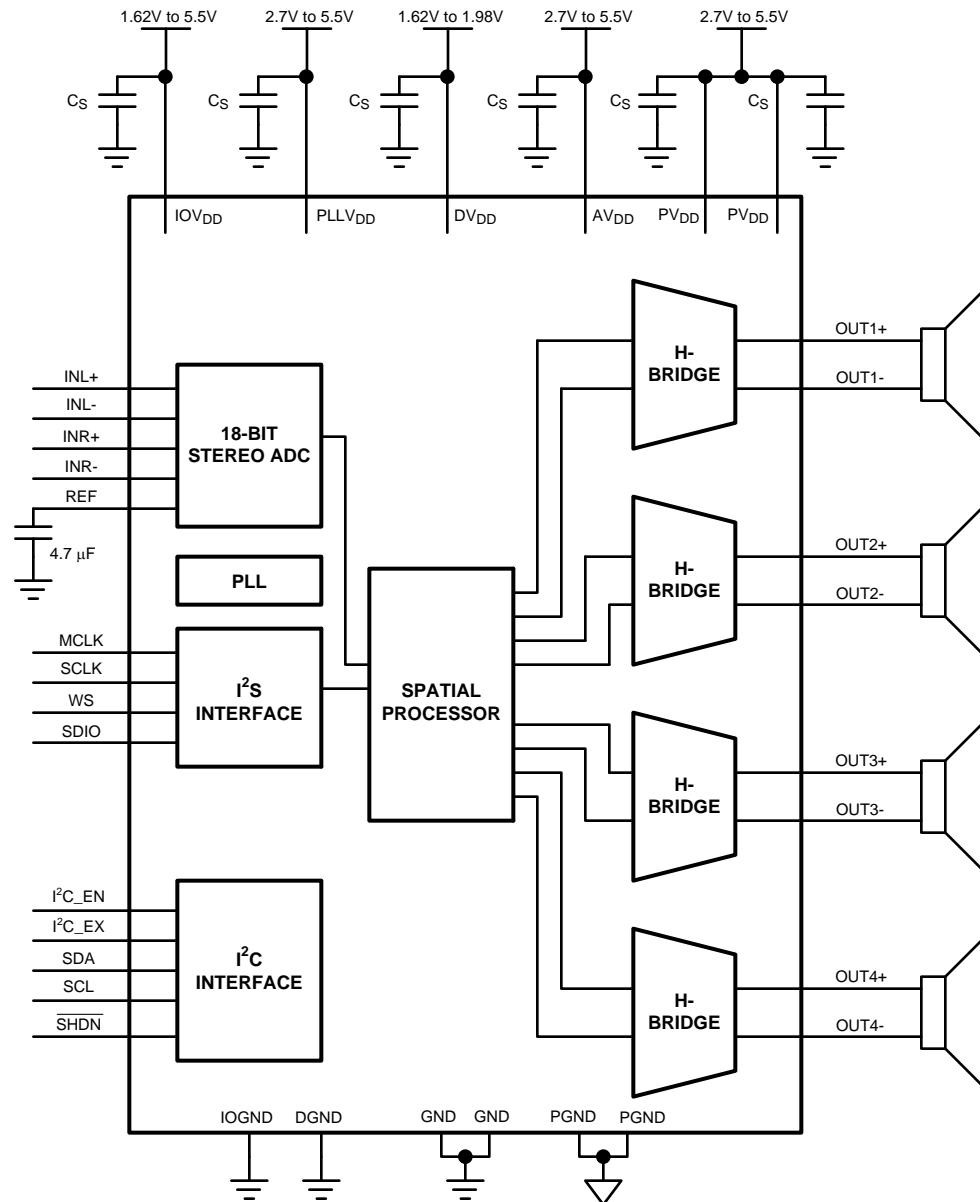


Figure 1. Typical Audio Amplifier Application Circuit

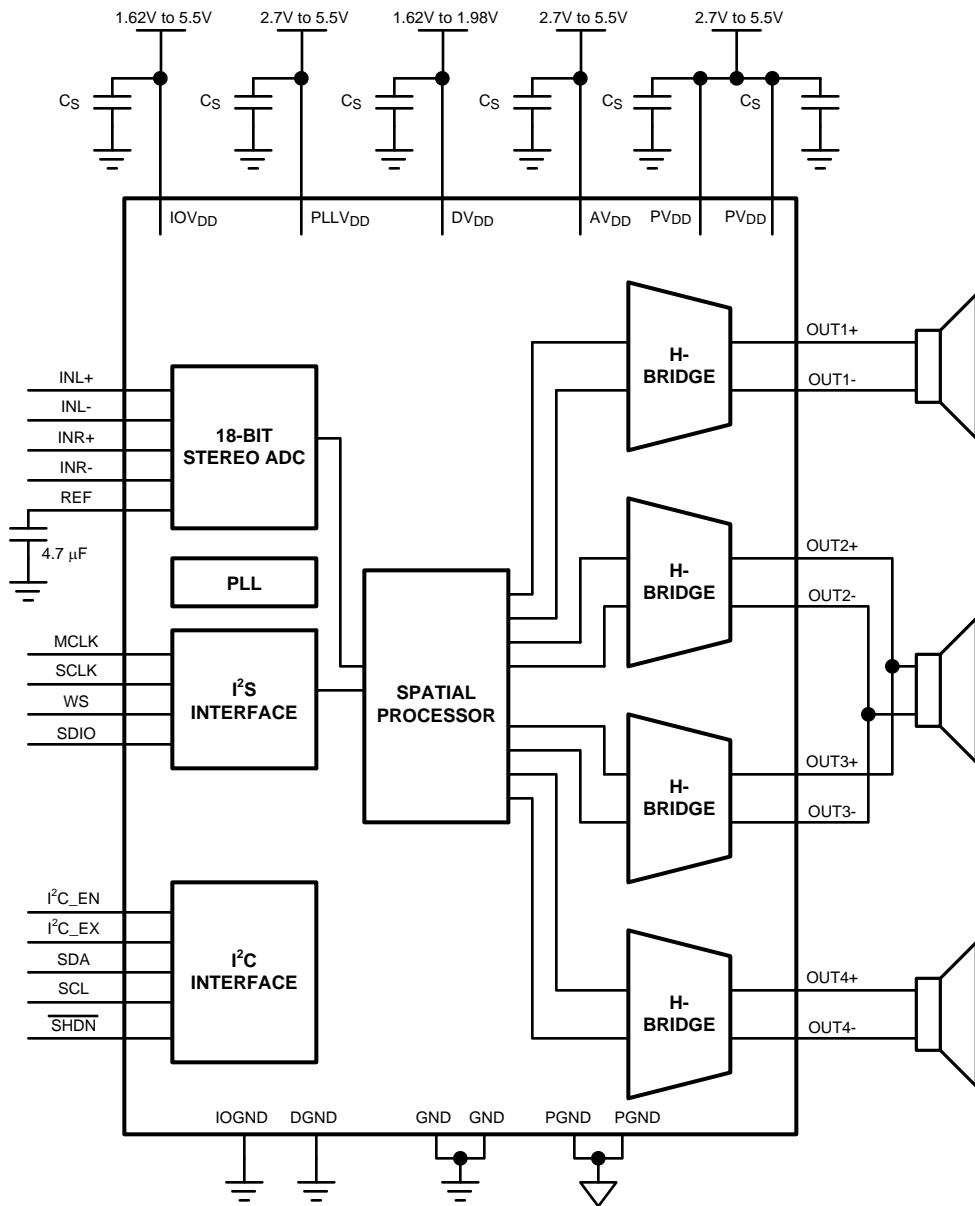


Figure 2. Channel Audio Amplifier Application Circuit

Only OUT2 and OUT3 can be configured in parallel. OUT1 and OUT4 cannot be configured in parallel.

Connection Diagram

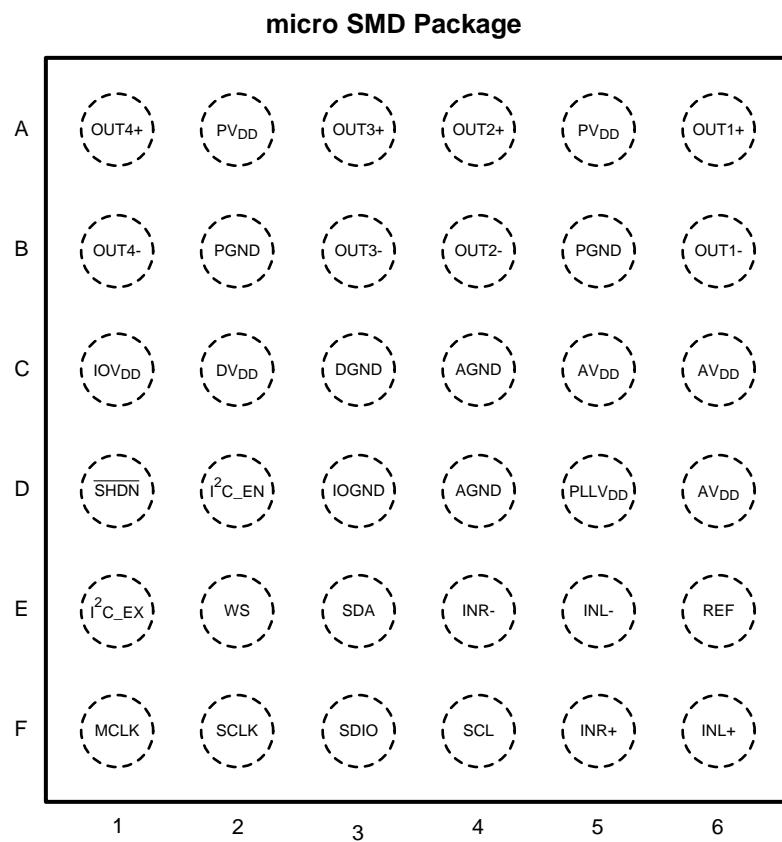


Figure 3. Top View

36-Bump micro SMD Marking

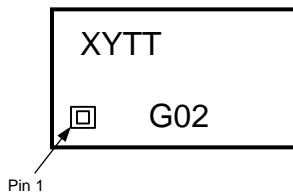


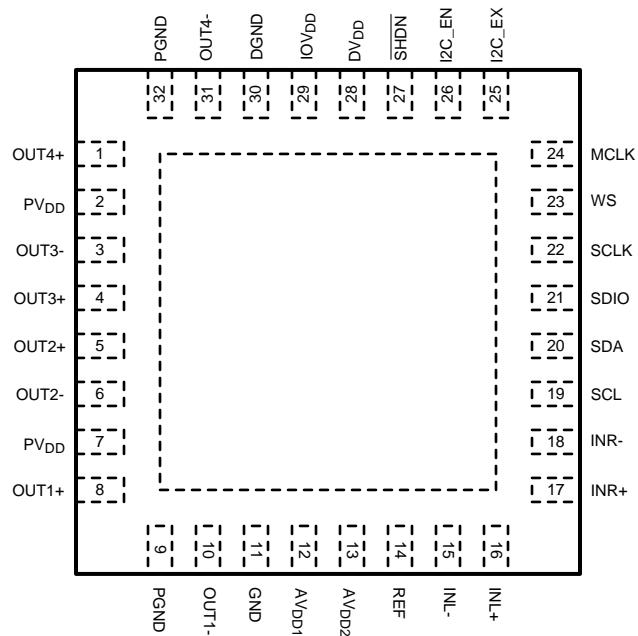
Figure 4. Top View

XY = Date code

TT = Die traceability

G = Boomer Family

02 = LM48901RL

SQ Package

Figure 5. Top View
Table 2. Pin Descriptions

| BUMP | PIN | NAME | DESCRIPTION |
|--------|-------|---------------------|--|
| A1 | 1 | OUT4+ | Channel 4 Non-Inverting Output |
| A2, A5 | 2, 7 | PVDD | Class D Power Supply |
| A3 | 4 | OUT3+ | Channel 3 Non-Inverting Output. Connect to OUT2+ in Parallel Mode. |
| A4 | 5 | OUT2+ | Channel 2 Non-Inverting Output. Connect to OUT3+ in Parallel Mode. |
| A6 | 8 | OUT1+ | Channel 1 Non-Inverting Output |
| B1 | 31 | OUT4- | Channel 4 Inverting Output |
| B2, B5 | 9, 32 | PGND | Power Ground |
| B3 | 3 | OUT3- | Channel 3 Inverting Output. Connect to OUT2- in Parallel Mode. |
| B4 | 6 | OUT2- | Channel 2 Inverting Output. Connect to OUT3- in Parallel Mode. |
| B6 | 10 | OUT1- | Channel 1 Inverting Output |
| C1 | 29 | IOVDD | Digital Interface Power Supply |
| C2 | 28 | DVDD | Digital Power Supply |
| C3 | 30 | DGND | Digital Ground |
| C4 | 11 | AGND1 | Modulator Analog Ground |
| C5 | — | AVDD3 | ADC Reference Power Supply |
| C6 | 12 | AVDD1 | Modulator Analog Power Supply. Set to same voltage as PV _{DD} for maximum headroom. |
| D1 | 27 | SHDN | Active Low Shutdown. Connect to V _{DD} for normal operation. |
| D2 | 26 | I ² C_EN | I ² C Enable Input |
| D3 | 30 | IOGND | Digital Interface Ground |
| D4 | — | AGND2 | ADC Analog Ground |

Table 2. Pin Descriptions (continued)

| BUMP | PIN | NAME | DESCRIPTION |
|------|-----|-------------------------------|---|
| D5 | — | PLL _{V_{DD}} | PLL Power Supply |
| D6 | 13 | AV _{DD2} | ADC Analog Power Supply |
| E1 | 25 | I ² C_EX | I ² C Enable Output |
| E2 | 23 | WS | I ² S Word Select Input |
| E3 | 20 | SDA | I ² C Serial Data Input |
| E4 | 18 | INR- | Right Channel Inverting Analog Input |
| E5 | 15 | INL- | Left Channel Inverting Analog Input |
| E6 | 14 | REF | ADC Reference Bypass |
| F1 | 24 | MCLK | Master Clock |
| F2 | 22 | SCLK | Serial Clock Input |
| F3 | 21 | SDIO | I ² S Serial Data Input/Output |
| F4 | 19 | SCL | I ² C Clock Input |
| F5 | 17 | INR+ | Right Channel Non-Inverting Analog Input |
| F6 | 16 | INL+ | Left Channel Non-Inverting Analog Input |



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings ⁽¹⁾ ⁽²⁾

| | |
|--|---------------------------------|
| Supply Voltage | |
| AV _{DD} , PV _{DD} , PLV _{DD} , IOV _{DD} ⁽¹⁾ | 6.0V |
| Supply Voltage, DV _{DD} ⁽¹⁾ | 2.2V |
| Storage Temperature | -65°C to + 150°C |
| Input Voltage | -0.3V to V _{DD} + 0.3V |
| Power Dissipation ⁽³⁾ | Internally limited |
| ESD Susceptibility ⁽⁴⁾ | 2000V |
| ESD Susceptibility ⁽⁵⁾ | 150V |
| Junction Temperature | 150°C |
| Thermal Resistance | |
| θ _{JA} (microSMD) | 26°C/W |
| θ _{JA} (LLP) | 26°C/W |
| θ _{JC} (LLP) | 2.6°C/W |

- (1) "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the *Absolute Maximum Ratings* or other conditions beyond those indicated in the *Recommended Operating Conditions* is not implied. The *Recommended Operating Conditions* indicate conditions at which the device is functional and the device should not be operated beyond such conditions. All voltages are measured with respect to the ground pin, unless otherwise specified.
- (2) The *Electrical Characteristics* tables list guaranteed specifications under the listed *Recommended Operating Conditions* except as otherwise modified or specified by the *Electrical Characteristics Conditions* and/or Notes. Typical specifications are estimations only and are not guaranteed.
- (3) The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX}, θ_{JA}, and the ambient temperature, T_A. The maximum allowable power dissipation is P_{DMAX} = (T_{JMAX} - T_A) / θ_{JA} or the given in *Absolute Maximum Ratings*, whichever is lower.
- (4) Human body model, applicable std. JESD22-A114C.
- (5) Machine model, applicable std. JESD22-A115-A.

Operating Ratings

| | |
|--|--------------------------------|
| Temperature Range | |
| T _{MIN} ≤ T _A ≤ T _{MAX} | -40°C ≤ T _A ≤ +85°C |
| Supply Voltage | |
| AV _{DD} | 2.7V ≤ AV _{DD} ≤ 5.5V |

Operating Ratings (continued)

| | |
|-------------|---------------------------------|
| PV_{DD} | $2.7V \leq PV_{DD} \leq 5.5V$ |
| $PLLV_{DD}$ | $2.7V \leq PLLV_{DD} \leq 5.5V$ |
| IOV_{DD} | $1.62V \leq IOV_{DD} \leq 5.5V$ |
| DV_{DD} | $1.62V \leq DV_{DD} \leq 1.98V$ |

Electrical Characteristics $PV_{DD} = AV_{DD} = 5V$, $IOV_{DD} = PLLV_{DD} = 3.3V$, $DV_{DD} = 1.8$ (1) (2)

The following specifications apply for $A_v = 0\text{dB}$, $C_{REF} = 4.7\mu\text{F}$, $R_L = 8\Omega$, $f = 1\text{kHz}$, unless otherwise specified. Limits apply for $T_A = 25^\circ\text{C}$.

| Symbol | Parameter | Conditions | LM48901 | | | Units (Limits) |
|-------------|---|---|------------|------------|------------|-------------------|
| | | | Min (2) | Typ (3) | Max (2) | |
| AV_{DD} | Analog Supply Voltage Range | (4) | 2.7 | | 5.5 | V |
| PV_{DD} | Amplifier Supply Voltage Range | (4) | 2.7 | | 5.5 | V |
| $PLLV_{DD}$ | PLL Supply Voltage Range | | 2.7 | | 5.5 | V |
| IOV_{DD} | Interface Supply Voltage Range | | 1.62 | | 5.5 | V |
| DV_{DD} | Digital Supply Voltage Range | | 1.62 | | 1.98 | V |
| AI_{DD} | Analog Quiescent Supply Current | LM48901RL | | 17.5 | 21 | mA |
| | | LM48901SQ | | 19.2 | 22.3 | mA |
| PI_{DD} | Amplifier Quiescent Supply Current | $R_L = 8\Omega$ | | 5.25 | 8.25 | mA |
| $PLLI_{DD}$ | PLL Quiescent Supply Current | LM48901RL | | 1.5 | | mA |
| DI_{DD} | Quiescent Digital Power Supply Current | | | 5.5 | 6.2 | mA |
| I_{SD} | Shutdown Current (Analog, Amplifier and PLL Supplies) | Shutdown Enabled | | 1 | 5 | μA |
| DI_{STBY} | Digital Standby Current | | | 30 | | μA |
| DI_{SD} | Digital Shutdown Current | Shutdown Enabled | | 2 | | μA |
| V_{OS} | Differential Output Offset Voltage | $V_{IN} = 0$ | -17 | 0 | 17 | mV |
| T_{WU} | Wake-up Time | Power Up (Device Initialization) | | 150 | | ms |
| | | From Shutdown | | 30 | | ms |
| f_{SW} | Switching Frequency | $f_S = 48\text{kHz}$ | | 384 | | kHz |
| P_O | Output Power/Channel | $R_L = 4\Omega$, THD+N = 10% $f = 1\text{kHz}$, 22kHz BW | | | | |
| | | $V_{DD} = 5V$ | | 2.8 | | W |
| | | $V_{DD} = 3.6V$ | | 1.4 | | W |
| | | $R_L = 4\Omega$, THD+N = 1% $f = 1\text{kHz}$, 22kHz BW | | | | |
| | | $V_{DD} = 5V$ | | 2.2 | | W |
| | | $V_{DD} = 3.6V$ | | 1.2 | | W |
| | | $R_L = 8\Omega$, THD+N = 10% $f = 1\text{kHz}$, 22kHz BW | | | | |
| | | $V_{DD} = 5V$ | | 1.7 | | W |
| | | $V_{DD} = 3.6V$ | | 825 | | mW |
| | | $R_L = 8\Omega$, THD+N = 1% $f = 1\text{kHz}$, 22kHz BW | | | | |
| | | $V_{DD} = 5V$ | 1.0 | 1.3 | | W |
| | | $V_{DD} = 3.6V$ | | 650 | | mW |

- (1) The *Electrical Characteristics* tables list guaranteed specifications under the listed *Recommended Operating Conditions* except as otherwise modified or specified by the *Electrical Characteristics Conditions* and/or Notes. Typical specifications are estimations only and are not guaranteed.
- (2) R_L is a resistive load in series with two inductors to simulate an actual speaker load. For $R_L = 8\Omega$, the load is $15\mu\text{H}+8\Omega+15\mu\text{H}$. For $R_L = 4\Omega$, the load is $15\mu\text{H}+4\Omega+15\mu\text{H}$.
- (3) Datasheet min/max specification limits are guaranteed by design, test, or statistical analysis.
- (4) Maintain PV_{DD} and AV_{DD} at the same voltage potential.

Electrical Characteristics $P_{V_{DD}} = A_{V_{DD}} = 5V$, $I_{OV_{DD}} = PLLV_{DD} = 3.3V$, $DV_{DD} = 1.8^{(1)(2)}$ (continued)

The following specifications apply for $A_V = 0\text{dB}$, $C_{REF} = 4.7\mu\text{F}$, $R_L = 8\Omega$, $f = 1\text{kHz}$, unless otherwise specified. Limits apply for $T_A = 25^\circ\text{C}$.

| Symbol | Parameter | Conditions | LM48901 | | | Units (Limits) |
|-------------------|--|--|------------|------------|------------|-------------------|
| | | | Min (2) | Typ (3) | Max (2) | |
| P _O | Output Power (Parallel Mode) ⁽⁵⁾ | $R_L = 4\Omega$, THD+N = 10%, $f = 1\text{kHz}$, 22kHz BW | | | | |
| | | $V_{DD} = 5V$ | | 3.2 | | W |
| | | $V_{DD} = 3.6V$ | | 1.6 | | W |
| | | $R_L = 4\Omega$, THD+N = 1%, $f = 1\text{kHz}$, 22kHz BW | | | | |
| | | $V_{DD} = 5V$ | | 2.5 | | W |
| | | $V_{DD} = 3.6V$ | | 1.2 | | W |
| THD+N | Total Harmonic Distortion + Noise | $P_O = 500\text{mW}$, $f = 1\text{kHz}$, $R_L = 8\Omega$ | | 0.06 | | % |
| PSRR | Power Supply Rejection Ratio (ADC Path) | $V_{RIPPLE} = 200\text{mV}_{P-P}$ sine, Inputs AC GND, $C_{IN} = 1\mu\text{F}$ | | | | |
| | | $f_{RIPPLE} = 217\text{Hz}$, Applied to $P_{V_{DD}}$ | | 67 | | dB |
| | | $f_{RIPPLE} = 217\text{Hz}$, Applied to DV_{DD} | | 54 | | dB |
| | | $f_{RIPPLE} = 1\text{kHz}$, Applied to $P_{V_{DD}}$ | | 66 | | dB |
| | | $f_{RIPPLE} = 1\text{kHz}$, Applied to DV_{DD} | | 54 | | dB |
| | | $f_{RIPPLE} = 10\text{kHz}$, Applied to $P_{V_{DD}}$ | | 57 | | dB |
| | | $f_{RIPPLE} = 10\text{kHz}$, Applied to DV_{DD} | | 52 | | dB |
| PSRR | Power Supply Rejection Ratio (I ² S Path) | $V_{RIPPLE} = 200\text{mV}_{P-P}$ sine, Inputs -120dBFS | | | | |
| | | $f_{RIPPLE} = 217\text{Hz}$, Applied to $P_{V_{DD}}$ | | 71 | | dB |
| | | $f_{RIPPLE} = 217\text{Hz}$, Applied to DV_{DD} | | 58 | | dB |
| | | $f_{RIPPLE} = 1\text{kHz}$, Applied to $P_{V_{DD}}$ | | 69 | | dB |
| | | $f_{RIPPLE} = 1\text{kHz}$, Applied to DV_{DD} | | 57 | | dB |
| | | $f_{RIPPLE} = 10\text{kHz}$, Applied to $P_{V_{DD}}$ | | 70 | | dB |
| | | $f_{RIPPLE} = 10\text{kHz}$, Applied to DV_{DD} | | 55 | | dB |
| CMRR | Common Mode Rejection Ratio | $V_{RIPPLE} = 1V_{P-P}$, $f_{RIPPLE} = 217\text{Hz}$, $A_V = 0\text{dB}$ | | 60 | | dB |
| η | Efficiency/Channel | $V_{DD} = 5V$, $P_O = 1.1\text{W}$ | | 89 | | % |
| | | $V_{DD} = 3.6V$, $P_O = 400\text{mW}$ | | 87 | | % |
| η | Efficiency | $V_{DD} = 5V$, $P_O = 1.1\text{W}$ | | 87 | | % |
| | | $V_{DD} = 3.6V$, $P_O = 400\text{mW}$ | | 86 | | % |
| SNR | Signal-to-Noise-Ratio | ADC Input, $P_O = 1\text{W}$ | | 85 | | dB |
| | | I ² S Input, $P_O = 1\text{W}$ | | 87 | | dB |
| CMVR | Common Mode Input Voltage Range | | | 5 | | V |
| ϵ_{OS} | Output Noise | Inputs AC GND, A-weighted, $A_V = 0\text{dB}$ | | 130 | | μV |
| | | I ² S Input | | 72 | | μV |
| X _{TALK} | Crosstalk | | | 75 | | dB |

(5) Only OUT2 and OUT3 can be configured in Parallel Mode.

I²C Interface Characteristics ⁽¹⁾ ⁽²⁾

The following specifications apply for $R_{PU} = 1\text{k}\Omega$ to IOV_{DD} , unless otherwise specified. Limits apply for $T_A = 25^\circ\text{C}$.

| Symbol | Parameter | Conditions | LM48901 | | | Units |
|--------|--|-------------------|------------------------|-----------------------|-----------------------|-------|
| | | | Min ⁽³⁾ | Typ ⁽⁴⁾ | Max ⁽³⁾ | |
| VIH | Logic Input High Threshold | SDA, SCL | 0.7* IOV_{DD} | | | V |
| VIL | Logic Input Low Threshold | SDA, SCL | | 300 | | mV |
| VOL | Logic Output Low Threshold | SDA, ISDA = 3.6mA | | | 0.35 | V |
| IOH | Logic Output High Current | SDA, SCL | | | 2 | uA |
| | SCL Frequency | | | | 400 | kHz |
| 1 | Hold Time (repeated START Condition) | | 0.6 | | | μs |
| 2 | Clock Low Time | | 1.3 | | | μs |
| 3 | Clock High Time | | 600 | | | ns |
| 4 | Setup Time for Repeated START condition | | 600 | | | ns |
| 5 | Data Hold Time | Output | 300 | | 900 | ns |
| 6 | Data Setup Time | | 100 | | | ns |
| 7 | SDA Rise Time | | | | 300 | ns |
| 8 | SDA Fall Time | | | | 300 | ns |
| 9 | Setup Time for STOP Condition | | 600 | | | ns |
| 10 | Bus Free Time Between STOP and START Condition | | 1.3 | | | μs |

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- (3) Datasheet min/max specification limits are guaranteed by design, test, or statistical analysis.
- (4) Typical values represent most likely parametric norms at $T_A = +25^\circ\text{C}$, and at the *Recommended Operation Conditions* at the time of product characterization and are not guaranteed.

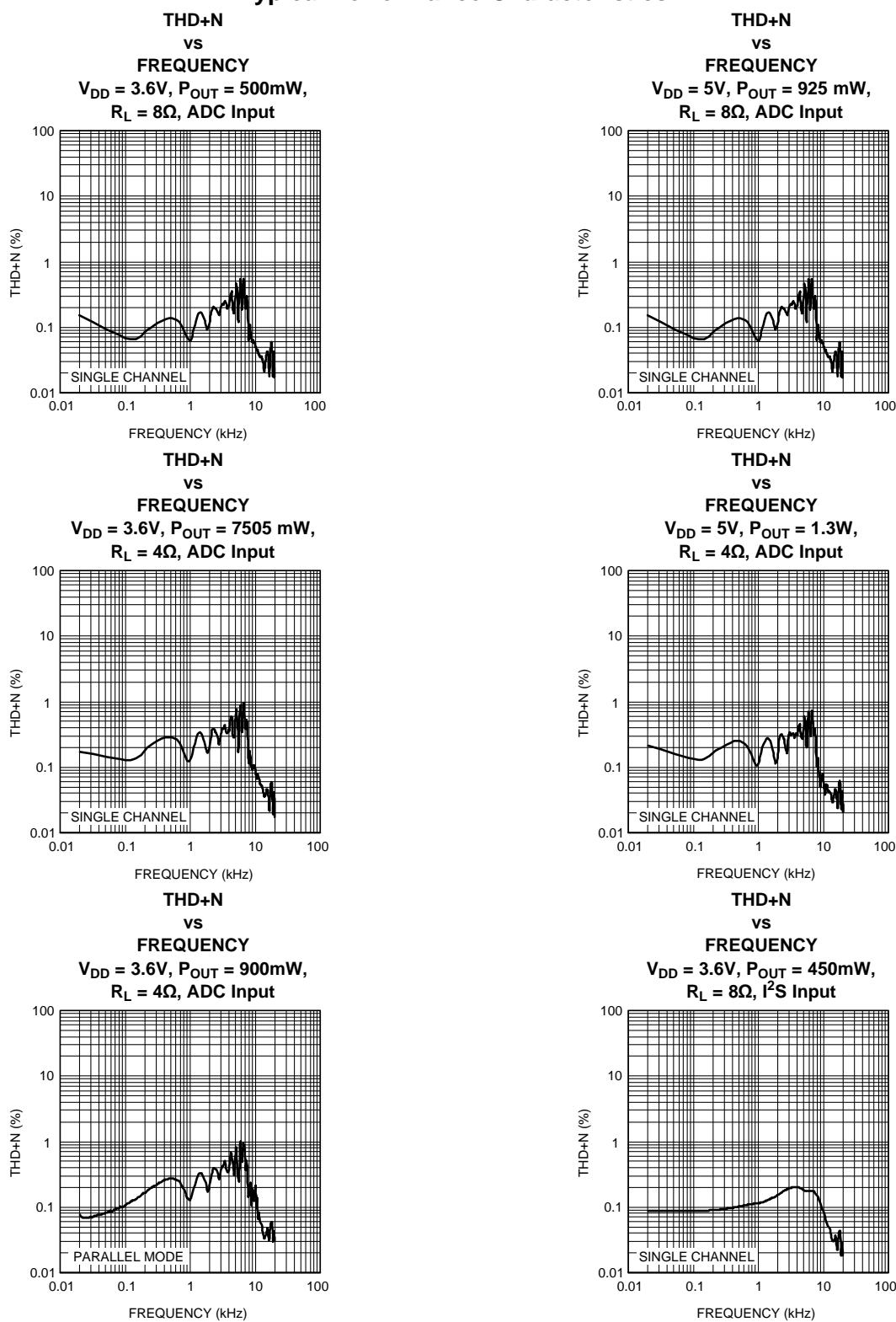
I²S Timing Characteristics ⁽¹⁾ ⁽²⁾

The following specifications apply for DV_{DD} = 1.8V, unless otherwise specified. Limits apply for T_A = 25°C.

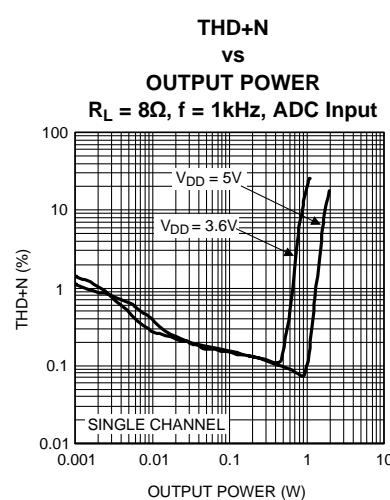
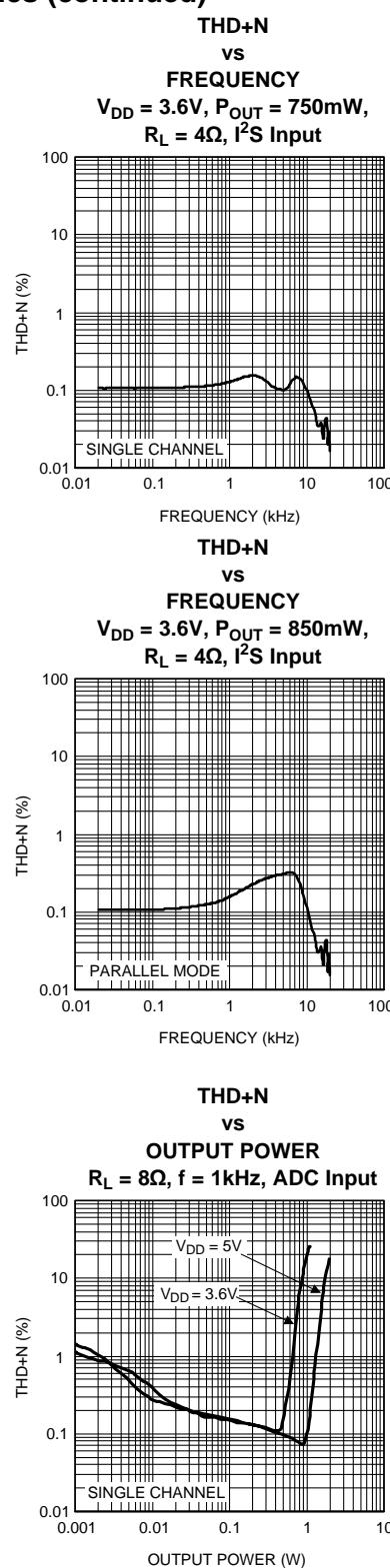
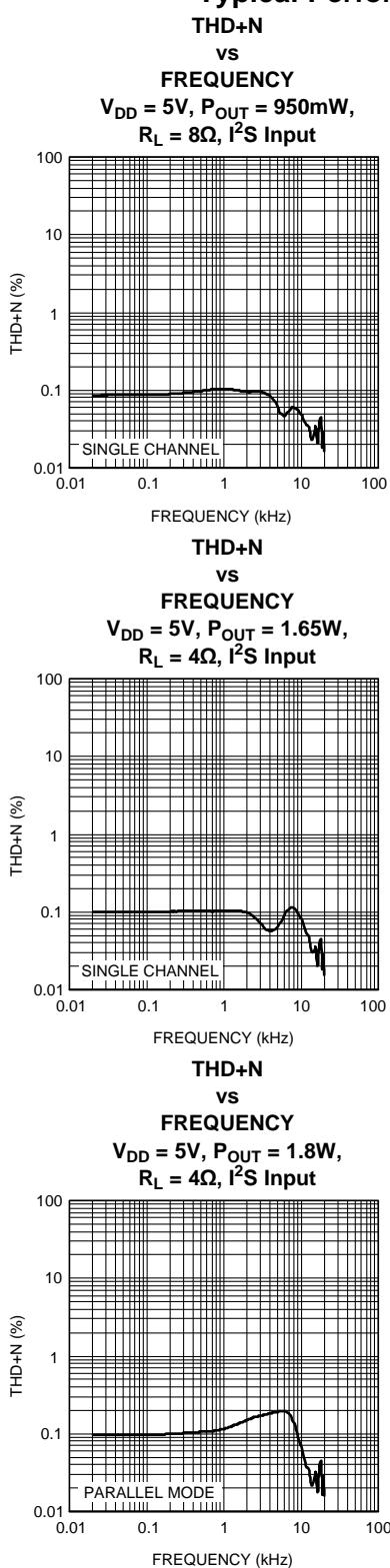
| Symbol | Parameter | Conditions | LM48901 | | | Units (Limits) |
|---------------------|--|------------|------------|------------|------------|-------------------|
| | | | Min (3) | Typ (4) | Max (3) | |
| t _{MCLKL} | MCLK Pulse Width Low | | 16 | | | ns |
| t _{MCLKH} | MCLK Pulse Width High | | 16 | | | ns |
| t _{MCLKY} | MCLK Period | | 27 | | | ns |
| t _{BCLKR} | SCLK rise time | | | | 3 | ns |
| t _{BCLKCF} | SCLK fall time | | | | 3 | ns |
| t _{BCLKDS} | SCLK Duty Cycle | | | 50 | | % |
| T _{DL} | LRC Propagation Delay from SCLK falling edge | | | | 10 | ns |
| T _{DST} | DATA Setup Time to SCLK Rising Edge | | 10 | | | ns |
| T _{DHT} | DATA Hold Time from SCLK Rising Edge | | 10 | | | ns |

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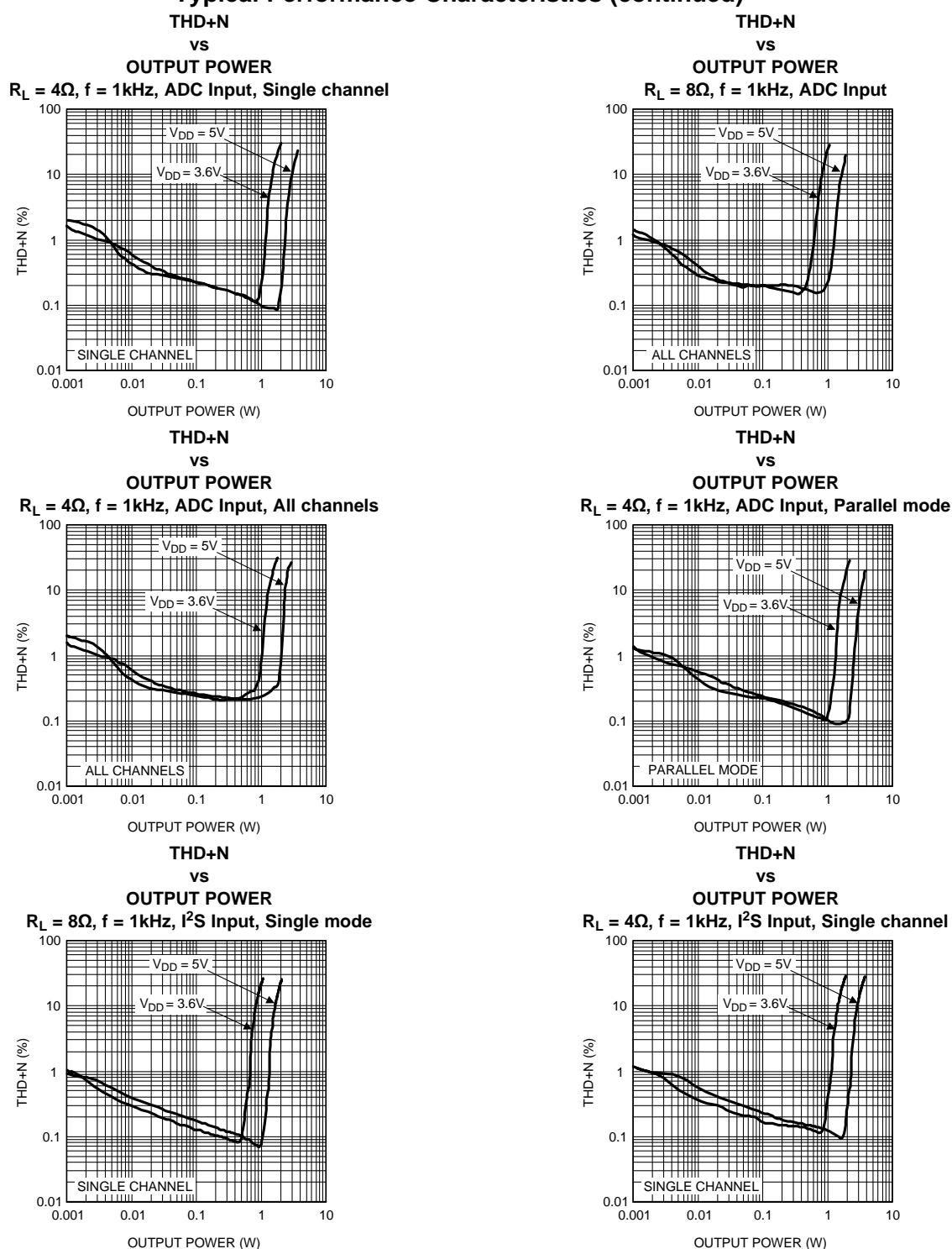
Typical Performance Characteristics



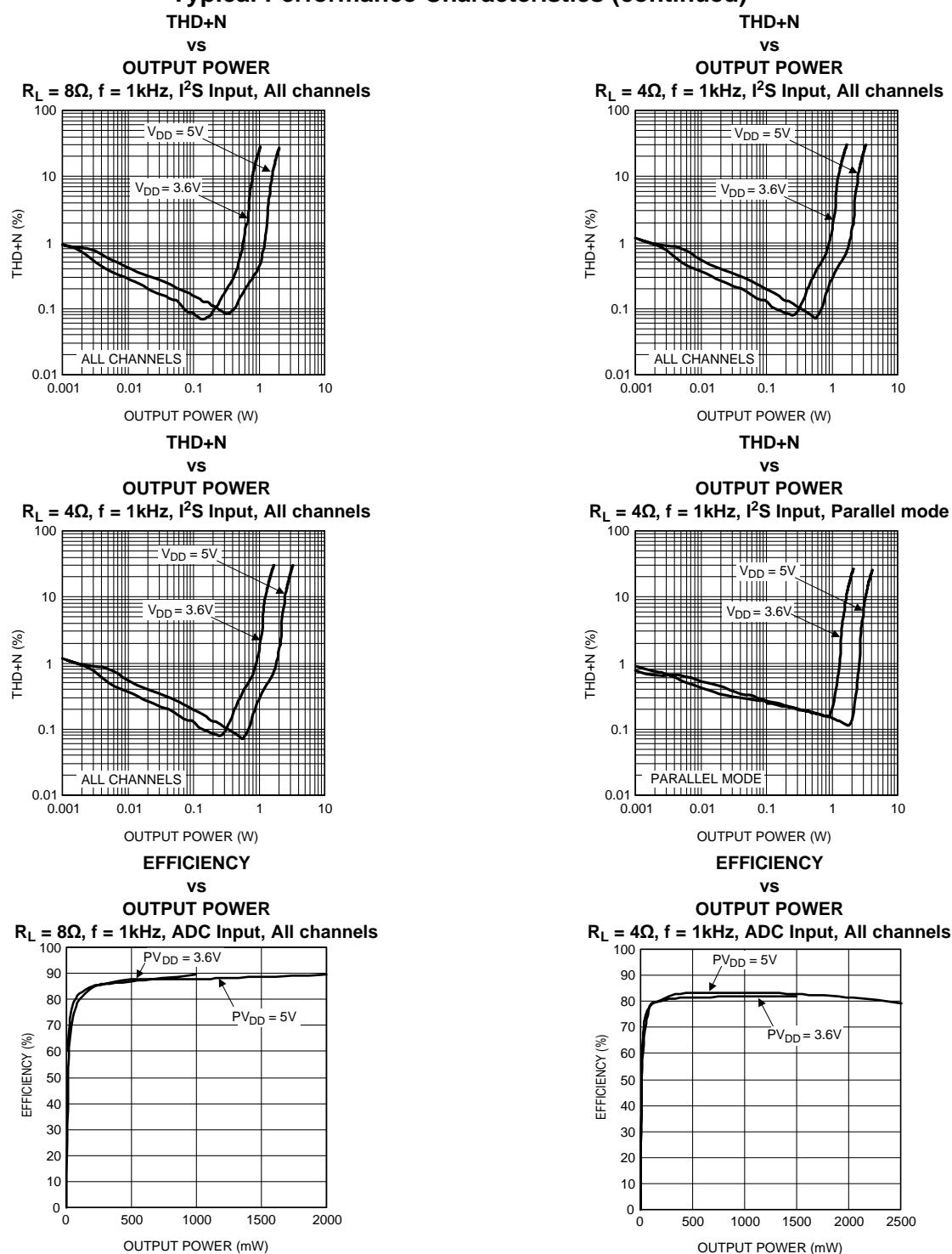
Typical Performance Characteristics (continued)



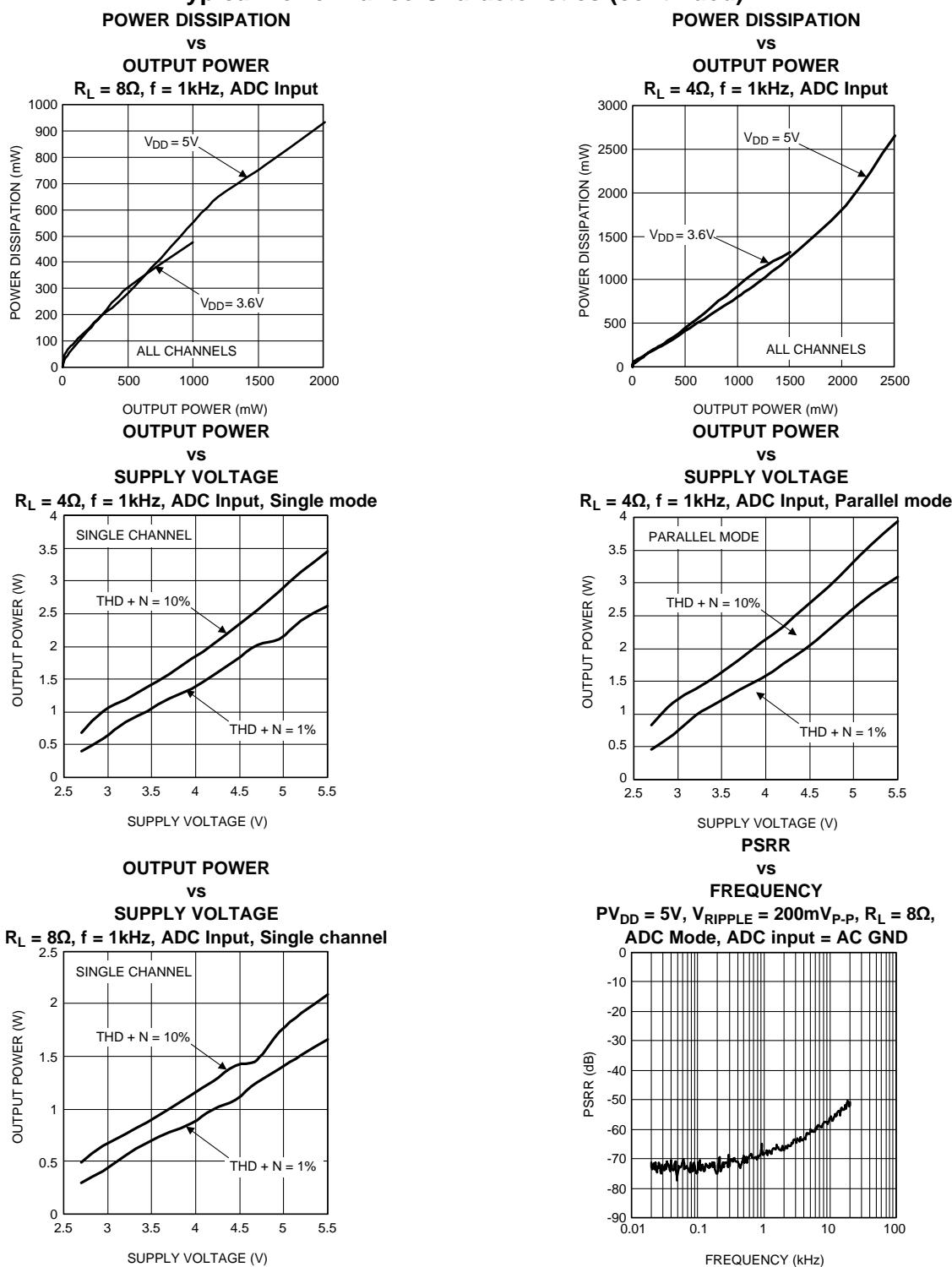
Typical Performance Characteristics (continued)



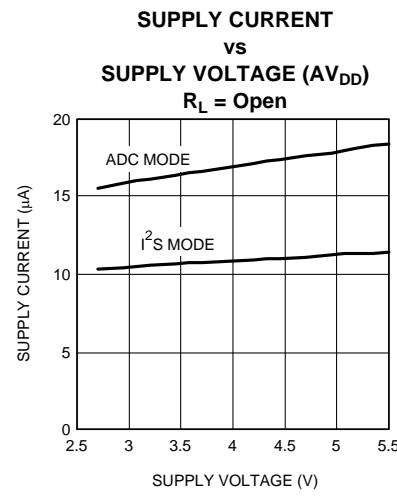
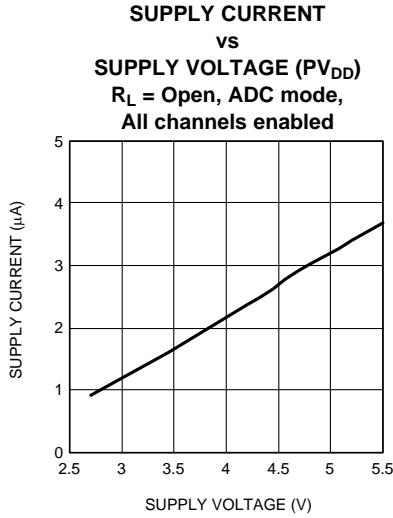
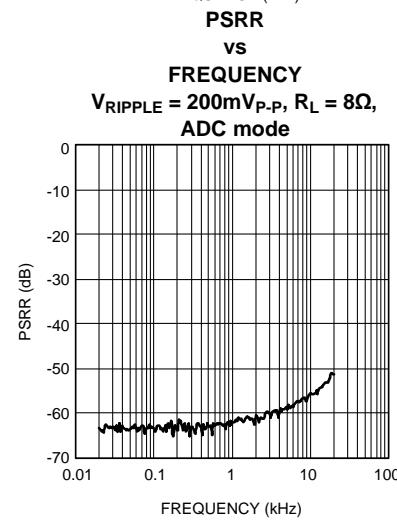
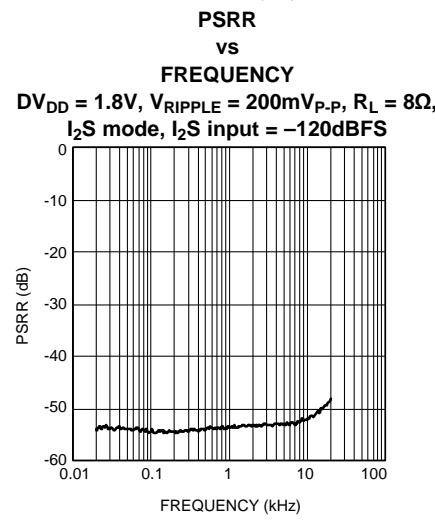
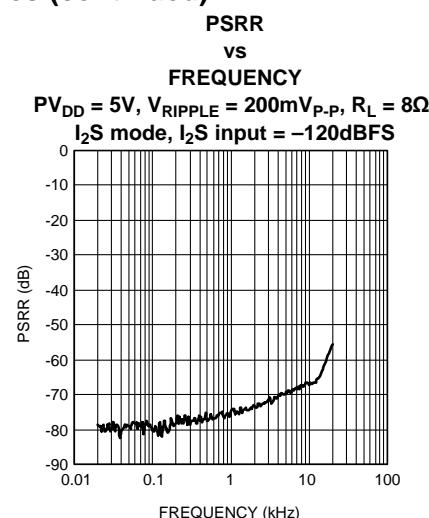
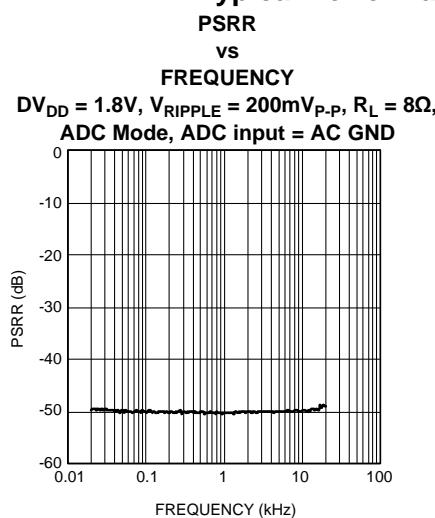
Typical Performance Characteristics (continued)



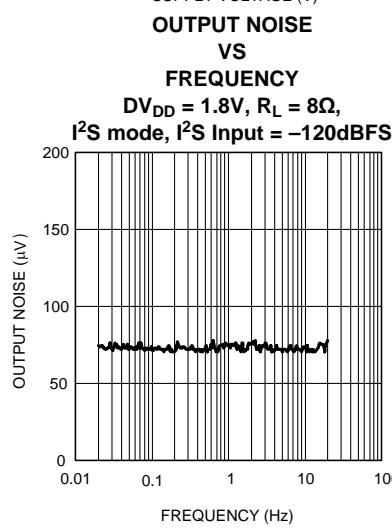
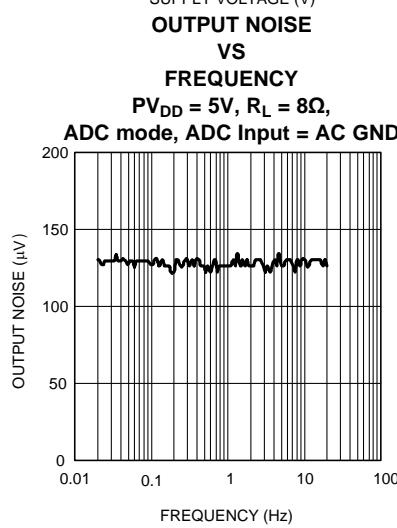
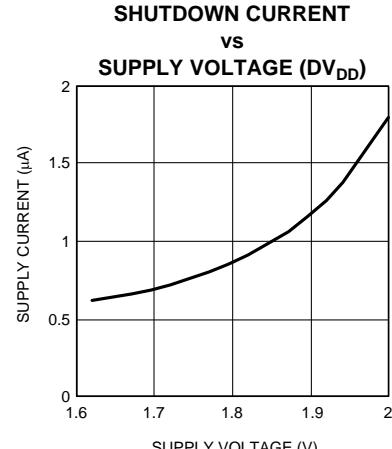
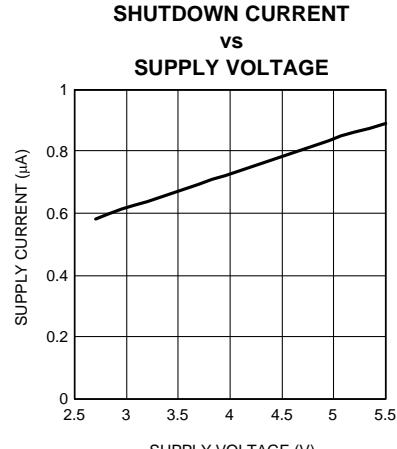
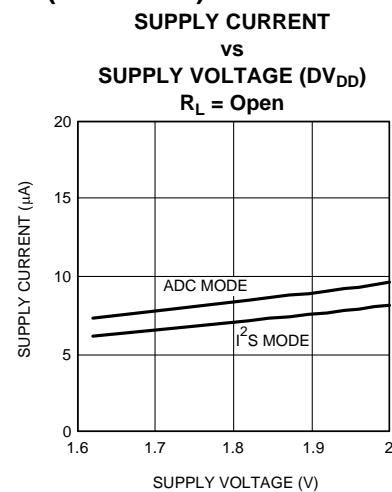
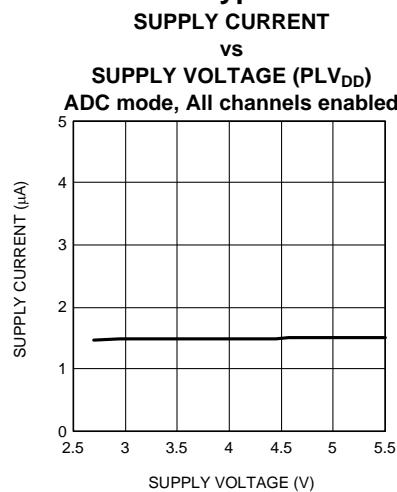
Typical Performance Characteristics (continued)



Typical Performance Characteristics (continued)



Typical Performance Characteristics (continued)



Application Information

I²C COMPATIBLE INTERFACE

The LM48901 is controlled through an I²C compatible serial interface that consists of a serial data line (SDA) and a serial clock (SCL). The clock and data lines are bi-directional (open drain). The LM48901 can communicate at clock rates up to 400kHz. [Figure 6](#) shows the I²C interface timing diagram. Data on the SDA line must be stable during the HIGH period of SCL. The LM48901 is a transmit/receive device, and can act as the I²C master, generating the SCL signal. Each transmission sequence is framed by a START condition and a STOP condition [Figure 7](#).

Due to the number of data registers, the LM48901 employs a page mode scheme. Each data write consists of 7, 8 bit data bytes, device address (1 byte), 16 bit register address (2 bytes), and 32 bit register data (4 bytes). Each byte is followed by an acknowledge pulse [Figure 8](#). Single byte read and write commands are ignored. The LM48901 device address is 0110000X.

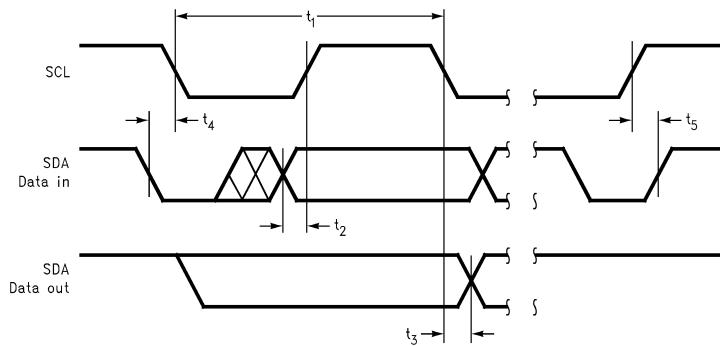


Figure 6. I²C Timing Diagram

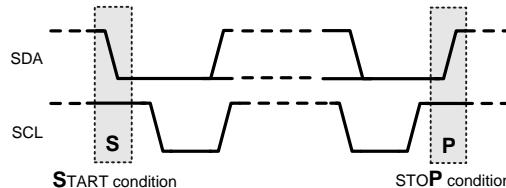


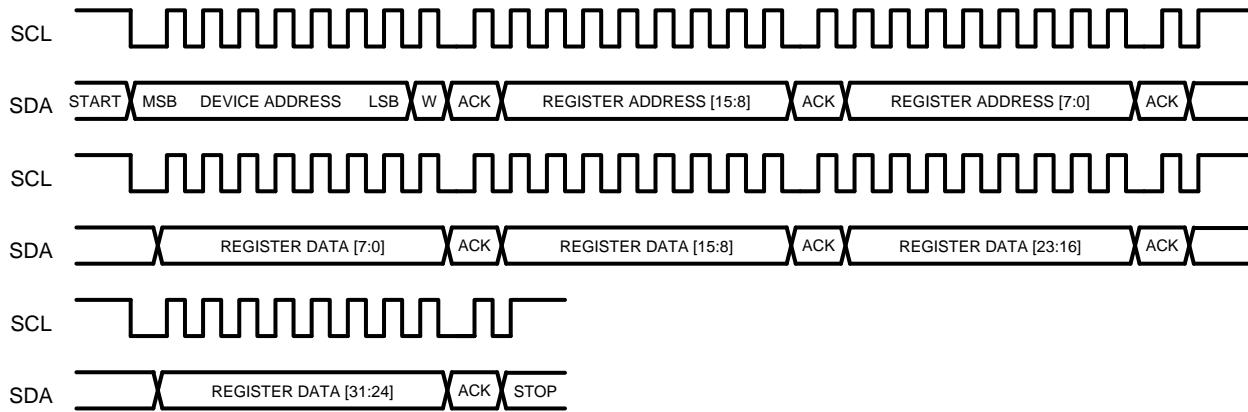
Figure 7. Start and Stop Diagram

WRITE SEQUENCE

The example write sequence is shown in [Figure 8](#). The START signal, the transition of SDA from HIGH to LOW while SDA is HIGH, is generated, altering all devices on the bus that a device address is being written to the bus.

The 7-bit device address is written to the bus, most significant bit (MSB) first, followed by the R/W bit (R/W = 0 indicating the master is writing to the LM48901). The data is latched in on the rising edge of the clock. Each address bit must be stable while SDA is HIGH. After the R/W bit is transmitted, the master device releases SDA, during which time, an acknowledge clock pulse is generated by the slave device. If the LM48901 receives the correct address, the device pulls the SDA line low, generating an acknowledge bit (ACK).

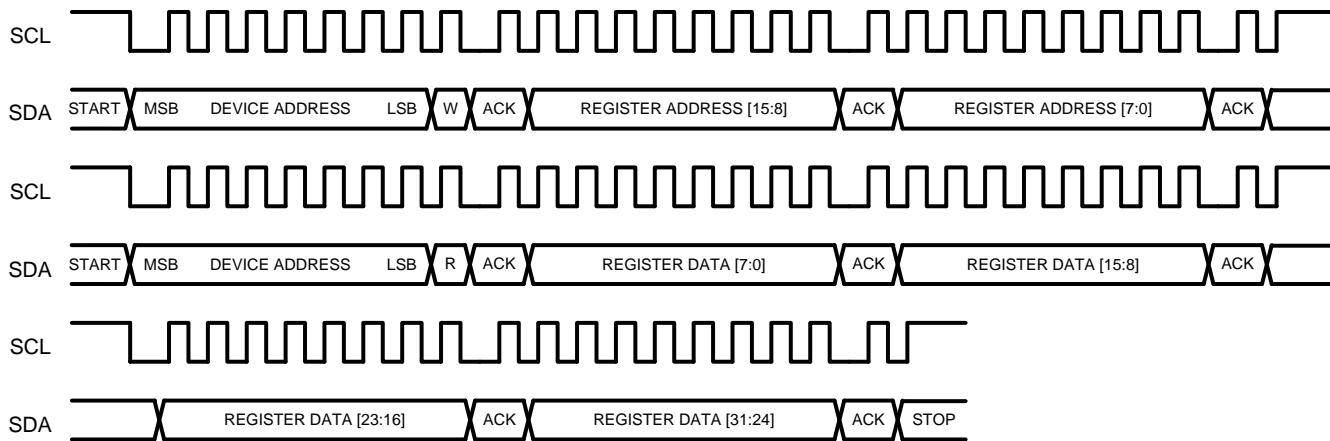
Once the master device registers the ACK bit, the first 8-bit register address word is sent, MSB first [15:8]. Each data bit should be stable while SCL is HIGH. After the first 8-bit register address is sent, the LM48901 sends another ACK bit. Upon receipt of acknowledge, the second 8-bit register address word is sent [7:0], followed by another ACK bit. The register data is sent, 8-bits at a time, MSB first in the following order [7:0], [15:8], [23:16], [31:24]. Each 8-bit word is followed by an ACK, upon receipt of which the successive 8-bit word is sent. Following the acknowledgement of the last register data word [31:24], the master issues a STOP bit, allowing SDA to go high while SDA is high.

Figure 8. Example I²C Write Sequence

READ SEQUENCE

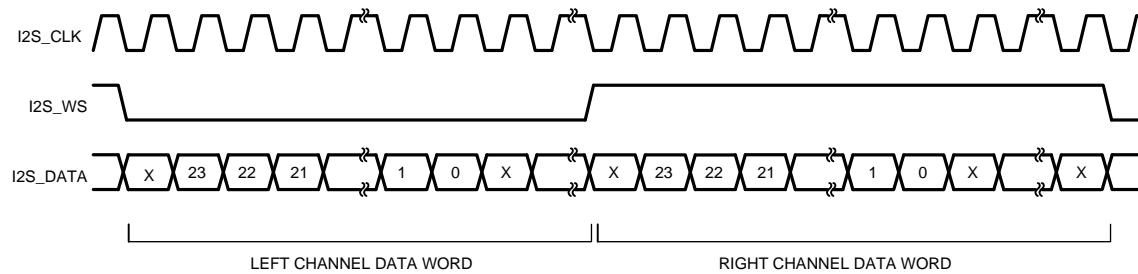
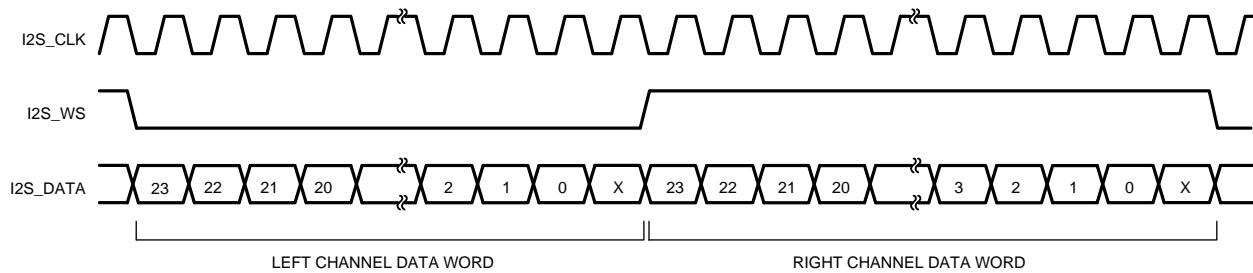
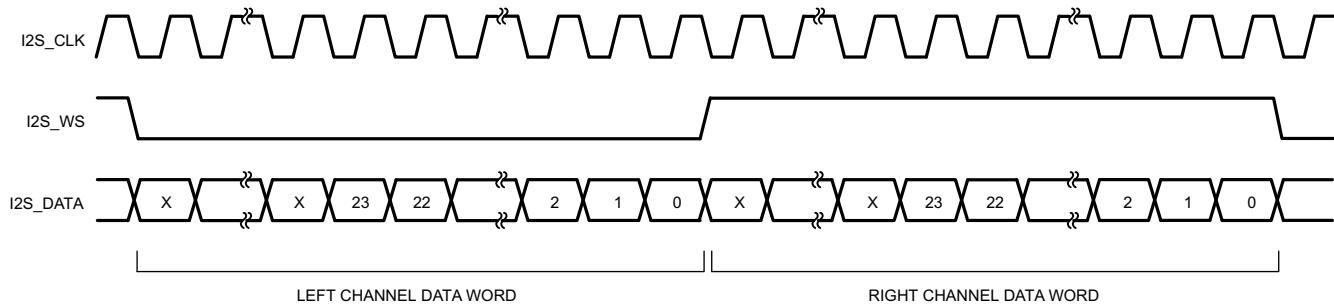
The example read sequence is shown in [Figure 9](#). The START signal, the transition of SDA from HIGH to LOW while SDA is HIGH, is generated, altering all devices on the bus that a device address is being written to the bus.

The 7-bit device address is written to the bus, followed by the R/W = 0. After the R/W bit is transmitted, the master device releases SDA, during which time, an acknowledge clock pulse is generated by the slave device. If the LM48901 receives the correct address, the device pulls the SDA line low, generating an acknowledge bit (ACK). Once the master device registers the ACK bit, the first 8-bit register address word is sent, MSB first [15:8], followed by an ACK from the LM48901. Upon receipt of the acknowledge, the second 8-bit register address word is sent [7:0], followed by another ACK bit. Following the acknowledgement of the last register address, the master initiates a REPEATED START, followed by the 7-bit device address, followed by R/W = 1 (R/W = 1 indicating the master wants to read data from the LM48901). The LM48901 sends an ACK, followed by the selected register data. The register data is sent, 8-bits at a time, MSB first in the following order [7:0], [15:8], [23:16], [31:24]. Each 8-bit word is followed by an ACK, upon receipt of which the successive 8-bit word is sent. Following the acknowledgement of the last register data word [31:24], the master issues a STOP bit, allowing SDA to go high while SDA is high.

Figure 9. Example I²C Read Sequence

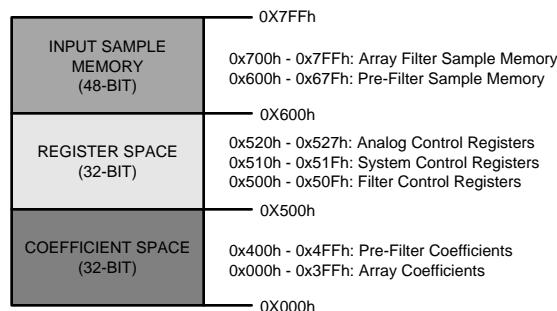
I²S DATA FORMAT

The LM48901 supports three I²S formats: Normal Mode [Figure 10](#), Left Justified Mode [Figure 11](#), and Right Justified Mode [Figure 12](#). In Normal Mode, the audio data is transmitted MSB first, with the unused bits following the LSB. In Left Justified Mode, the audio data format is similar to the Normal Mode, without the delay between the LSB and the change in I²S_WS. In Right Justified Mode, the audio data MSB is transmitted after a delay of a preset number of bits.


Figure 10. I²S Normal Input Format

Figure 11. I²S Left Justified Input Format

Figure 12. I²S Right Justified Input Format

MEMORY ORGANIZATION

The LM48901 memory is organized into three main regions: a 32-bit wide Coefficient Space that holds the spatial coefficients, a 32-bit wide Register Space that holds the device configuration settings, and a 48-bit wide Audio Sample Space that holds the current audio data sampled from either the ADCs or the I²S interface, organized as shown in [Figure 13](#).


Figure 13. LM48901 Memory Organization

COEFFICIENT MEMORY

The device must be in Debug mode in order to write to the Coefficient memory. Set Bit 7 (DBG_ENABLE) in Filter Debug Register 1 (0x504h) = 1 to enable Debug mode. The Coefficient Memory Space is organized as follows.

Table 3. Coefficient Memory Space

| REGISTER ADDRESS | | REGISTER CONTENTS | |
|------------------------|--|--|---|
| | | (31:16) | (15:0) |
| 0x000h - 0x0FFh | | 256x16 bit Array Taps (Right Input to OUT4) | 256x16 bit Array Taps (Left Input to OUT4) |
| | | 256x16 bit Array Taps (Right Input to OUT3) | 256x16 bit Array Taps (Left Input to OUT3) |
| 0x200h - 0x2FFh | | 256x16 bit Array Taps (Right Input to OUT2) | 256x16 bit Array Taps (Left Input to OUT2) |
| | | 256x16 bit Array Taps (Right Input to OUT1) | 256x16 bit Array Taps (Left Input to OUT1) |
| 0x400h - 0x47Eh (EVEN) | | C2 128x16 bit Prefilter Taps (Right to Right) | C0 128x16 bit Prefilter FIR Taps (Left to Left) |
| | | C3 128x16 bit Prefilter Taps (Right to Left) | C1 128x16 bit Prefilter FIR Taps (Left to Right) |

CONTROL REGISTERS

Table 4. Register Map

| Register Name | Register Address | Default Value | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
|----------------|------------------|---------------|-------------------|-----------------|------------------|-------------------|----------|------------|---------|---|--|--|--|
| FILTER CONTROL | 0x500h [7:0] | 0xFFh | ARRAY_TAP | | | | | | | | | | |
| | 0x500h [15:8] | 0xFFh | UNUSED | | PRE_TAP | | | | | | | | |
| | 0x500h [23:16] | 0xE4h | CH4_SEL | | CH3_SEL | | CH2_SEL | | CH1_SEL | | | | |
| | 0x500h [31:24] | 0x31h | ARRAY_ ENABLE | PRE_ ENABLE | ARRAY_ BYPASS | PRE_ BYPASS | UNUSED | | | | | | |
| FILTER COMP1 | 0x501h [7:0] | 0x00h | G1_GAIN | | | COMP_TH | | | | | | | |
| | 0x501h [15:8] | 0x00h | UNUSED | POST_GAIN | | | UNUSED | COMP_RATIO | | | | | |
| | 0x501h [23:16] | 0x00h | ARRAY_COMP_SELECT | | | | | | | | | | |
| | 0x501h [31:24] | 0x00h | UNUSED | | | | | | | | | | |
| FILTER COMP2 | 0x502h [7:0] | 0x00h | G1_GAIN | | | COMP_TH | | | | | | | |
| | 0x502h [15:8] | 0x00h | UNUSED | POST_GAIN | | | UNUSED | COMP_RATIO | | | | | |
| | 0x502h [23:16] | 0x00h | G1_GAIN | | | COMP_TH | | | | | | | |
| | 0x502h [31:24] | 0x00h | UNUSED | POST_GAIN | | | UNUSED | COMP_RATIO | | | | | |
| FILTER DEBUG0 | 0x503h [7:0] | 0xFFh | DBG_DATA [7:0] | | | | | | | | | | |
| | 0x503h [15:8] | 0xFFh | DBG_DATA [15:8] | | | | | | | | | | |
| | 0x503h [23:16] | 0xFFh | DBG_DATA [23:16] | | | | | | | | | | |
| | 0x503h [31:24] | 0xFFh | DBG_ STEP | UNUSED | | | | | | | | | |
| FILTER DEBUG1 | 0x504h [7:0] | 0xFFh | DBG_ ENABLE | STEP_ ENABLE | UNUSED | FILTER_ SELECT | ACC_ADDR | | | | | | |
| | 0x504h [15:8] | 0xFFh | UNUSED | | | | | | | | | | |
| | 0x504h [23:16] | 0xFFh | UNUSED | | | | | | | | | | |
| | 0x504h [31:24] | 0xFFh | UNUSED | | | | | | | | | | |

Table 4. Register Map (continued)

| Register Name | Register Address | Default Value | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | | | | | | | | |
|--------------------------|------------------|---------------|------------------|---------------|---|---|-------------|---|------|--------|--|--|--|--|--|--|--|--|--|--|--|
| FILTER STATS | 0x505h [7:0] | 0x00h | COUNT1_MODE | | | | CH_SEL | | | | | | | | | | | | | | |
| | 0x505h [15:8] | 0x80h | CLEAR | UNUSED | | | COUNT2_MODE | | | | | | | | | | | | | | |
| | 0x505h [23:16] | 0x00h | COUNT1_MODE | | | | CH_SEL | | | | | | | | | | | | | | |
| | 0x505h [31:24] | 0x80h | CLEAR | UNUSED | | | COUNT2_MODE | | | | | | | | | | | | | | |
| FILTER TAP (READ-ONLY) | 0x508h [7:0] | 0x7Fh | TAP_LENGTH | | | | | | | | | | | | | | | | | | |
| | 0x508h [15:8] | 0x00h | UNUSED | | | | | | | | | | | | | | | | | | |
| | 0x508h [23:16] | 0x00h | UNUSED | | | | | | | | | | | | | | | | | | |
| | 0x508h [31:24] | 0x00h | UNUSED | | | | | | | | | | | | | | | | | | |
| ACCUML DEBUG (READ-ONLY) | 0x509h [7:0] | 0x00h | DBG_ACCL [7:0] | | | | | | | | | | | | | | | | | | |
| | 0x509h [15:8] | 0x00h | DBG_ACCL [15:8] | | | | | | | | | | | | | | | | | | |
| | 0x509h [23:16] | 0x00h | DBG_ACCL [23:16] | | | | | | | | | | | | | | | | | | |
| | 0x509h [31:24] | 0x00h | DBG_ACCL [31:24] | | | | | | | | | | | | | | | | | | |
| ACCUMH DEBUG (READ-ONLY) | 0x50Ah [7:0] | 0x00h | DBG_ACCH | | | | | | | | | | | | | | | | | | |
| | 0x50Ah [15:8] | 0x00h | BDG_ACCH | | | | | | | | | | | | | | | | | | |
| | 0x50Ah [23:16] | 0x00h | UNUSED | | | | | | | | | | | | | | | | | | |
| | 0x50Ah [31:24] | 0x00h | UNUSED | | | | | | | | | | | | | | | | | | |
| DBG SAT (READ-ONLY) | 0x50Bh [7:0] | 0x00h | DBG_SAT [7:0] | | | | | | | | | | | | | | | | | | |
| | 0x50Bh [15:8] | 0x00h | DBG_SAT [15:8] | | | | | | | | | | | | | | | | | | |
| | 0x50Bh [23:16] | 0x00h | DBG_SAT [23:16] | | | | | | | | | | | | | | | | | | |
| | 0x50Bh [31:24] | 0x00h | UNUSED | | | | | | | | | | | | | | | | | | |
| STAT PCNT1 (READ-ONLY) | 0x50Ch [7:0] | 0x00h | COUNT [7:0] | | | | | | | | | | | | | | | | | | |
| | 0x50Ch [15:8] | 0x00h | COUNT [15:8] | | | | | | | | | | | | | | | | | | |
| | 0x50Ch [23:16] | 0x00h | COUNT [23:16] | | | | | | | | | | | | | | | | | | |
| | 0x50Ch [31:24] | 0x00h | OVF | COUNT [30:24] | | | | | | | | | | | | | | | | | |
| STAT PCNT2 (READ-ONLY) | 0x50Dh [7:0] | 0x00h | COUNT [7:0] | | | | | | | | | | | | | | | | | | |
| | 0x50Dh [15:8] | 0x00h | COUNT [15:8] | | | | | | | | | | | | | | | | | | |
| | 0x50Dh [23:16] | 0x00h | COUNT [23:16] | | | | | | | | | | | | | | | | | | |
| | 0x50Dh [31:24] | 0x00h | OVF | COUNT [30:24] | | | | | | | | | | | | | | | | | |
| STAT ACNT1 (READ-ONLY) | 0x50Eh [7:0] | 0x00h | COUNT [7:0] | | | | | | | | | | | | | | | | | | |
| | 0x50Eh [15:8] | 0x00h | COUNT [15:8] | | | | | | | | | | | | | | | | | | |
| | 0x50Eh [23:16] | 0x00h | COUNT [23:16] | | | | | | | | | | | | | | | | | | |
| | 0x50Eh [31:24] | 0x00h | OVF | COUNT [30:24] | | | | | | | | | | | | | | | | | |
| STAT ACNT2 (READ-ONLY) | 0x50Fh [7:0] | 0x00h | COUNT [7:0] | | | | | | | | | | | | | | | | | | |
| | 0x50Fh [15:8] | 0x00h | COUNT [15:8] | | | | | | | | | | | | | | | | | | |
| | 0x50Fh [23:16] | 0x00h | COUNT [23:16] | | | | | | | | | | | | | | | | | | |
| | 0x50Fh [31:24] | 0x00h | OVF | COUNT [30:24] | | | | | | | | | | | | | | | | | |
| SYS CONFIG | 0x530h [7:0] | 0x30h | CONFIG | DEVICE_ID | | | | | | | | | | | | | | | | | |
| | | | _CLK_ | | | | | | | | | | | | | | | | | | |
| | | | ENABLE | | | | | | | | | | | | | | | | | | |
| | 0x530h [15:8] | 0x00h | ALTID_ | ALT_DEVICE_ID | | | | | | | | | | | | | | | | | |
| | ENABLE | | | | | | | | | | | | | | | | | | | | |
| | 0x530h [23:16] | 0x8Ch | CL_ | UNUSED | | | CL_PAGE | | CL_W | CL_REQ | | | | | | | | | | | |
| | ENABLE | MBIST1_ | MBIST0_ | | | | | | | | | | | | | | | | | | |
| | 0x530h [31:24] | 0x00h | UNUSED | | | | | | | ENABLE | | | | | | | | | | | |

Table 4. Register Map (continued)

| Register Name | Register Address | Default Value | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
|---------------------------|------------------|---------------|---------------------------|----------------------|--------------------------|-----------------|--------------------------|-----------|----------------------|---------|--|--|--|--|
| CL REG0 | 0x531h [7:0] | 0x00h | TRANS_LENGTH [7:0] | | | | | | | | | | | |
| | 0x531h [15:8] | 0x10h | TRANS_LENGTH [15:8] | | | | | | | | | | | |
| | 0x531h [23:16] | 0x00h | REG_START_ADDR [7:0] | | | | | | | | | | | |
| | 0x531h [31:24] | 0x00h | REG_START_ADDR [16:8] | | | | | | | | | | | |
| CL REG1 | 0x532h [7:0] | 0x00h | E2_START_ADDR [7:0] | | | | | | | | | | | |
| | 0x532h [15:8] | 0x00h | E2_START_ADDR [15:8] | | | | | | | | | | | |
| | 0x532h [23:16] | 0x00h | UNUSED | | | | | | | | | | | |
| | 0x532h [31:24] | 0x00h | UNUSED | | | | | | | | | | | |
| E2_OFFSET | 0x533h [7:0] | 0x00h | UNUSED | | E2_OFFSET | | | | | | | | | |
| | 0x533h [15:8] | 0x00h | UNUSED | | | | | | | | | | | |
| | 0x533h [23:16] | 0x00h | UNUSED | | | | | | | | | | | |
| | 0x533h [31:24] | 0x00h | UNUSED | | | | | | | | | | | |
| I ² C_EnXT | 0x534h [7:0] | 0x00h | I ² C _EnXT | UNUSED | E2NXT_OFFSET | | | | | | | | | |
| | 0x534h [15:8] | 0x00h | UNUSED | | | | | | | | | | | |
| | 0x534h [23:16] | 0x00h | UNUSED | | | | | | | | | | | |
| | 0x534h [31:24] | 0x00h | UNUSED | | | | | | | | | | | |
| MBIST STAT (READ-ONLY) | 0x538h [7:0] | 0x7Fh | UNUSED | | MBIST_EN | | MBIST_GO | | MBIST_DONE | | | | | |
| | 0x538h [15:8] | 0x80h | UNUSED | | | | | | | | | | | |
| | 0x538h [23:16] | 0x00h | UNUSED | | | | | | | | | | | |
| | 0x538h [31:24] | 0x80h | UNUSED | | | | | | | | | | | |
| DELAY | 0x520h [7:0] | 0x06h | POWER_UP_DELAY [7:0] | | | | | | | | | | | |
| | 0x520h [15:8] | 0x00h | POWER_UP_DELAY [15:8] | | | | | | | | | | | |
| | 0x520h [23:16] | 0x20h | DEGLITCH_DELAY | | | | | | | | | | | |
| | 0x520h [31:24] | 0x09h | STATE_DELAY | | | | | | | | | | | |
| ENABLE & CLOCKS | 0x521h [7:0] | 0x00h | UNUSED | | | | VREF_ DELAY | PULSE | FORCE | ENABLE | | | | |
| | 0x521h [15:8] | 0x00h | UNUSED | QSA_ CLK_ STOP | HIFI | PCM_ CLK_SEL | I2S_CLK | MCLK_RATE | | | | | | |
| | 0x521h [23:16] | 0x00h | UNUSED | | | | ADC_ SYNC | | | | | | | |
| | 0x521h [31:24] | 0x00h | UNUSED | | | | | | | | | | | |
| DIGITAL MIXER | 0x522h [7:0] | 0x33h | ZERO_ CROSS | MUTE | ADC_LVL | | | | | | | | | |
| | 0x522h [15:8] | 0x33h | UNUSED | | I ² S_LVL | | | | | | | | | |
| | 0x522h [23:16] | 0x00h | I ² SB_ON | I ² SA_ON | I ² SB_TX_SEL | | I ² SA_TX_SEL | ADC_DSP | I ² S_DSP | | | | | |
| | 0x522h [31:24] | 0x00h | OUT4_SEL | | OUT3_SEL | | OUT2_SEL | OUT1_SEL | | | | | | |
| ANALOG | 0x523h [7:0] | 0x00h | BYPASS_ MOD | AUTO_ SD | ADC TRIM | ZERO_ DIG | ZERO_ ANA | PARALLEL | ANA_LVL | | | | | |
| | 0x523h [15:8] | 0x00h | UNUSED | | | SE_MOD | PMC_ TEST | TSD_DIS | SCKT_ DIS | TST_SHT | | | | |
| | 0x523h [23:16] | 0x00h | UNUSED | | | | | | | | | | | |
| | 0x523h [31:24] | 0x00h | UNUSED | | | | | | | | | | | |

Table 4. Register Map (continued)

| Register Name | Register Address | Default Value | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
|-----------------------|------------------|---------------|--------------------------|---------------|--------------------|----------|----------|-----------|--------|--------|--|--|--|--|
| I ² S PORT | 0x524h [7:0] | 0x01h | SYNC_ | STEREO_S_YNC_ | CLOCK_ | SYNC_MS | CLK_MS | TX_ | RX_ | STEREO | | | | |
| | MODE | | PHASE | PHASE | PHASE | | | ENABLE | ENABLE | | | | | |
| | 0x524h [15:8] | 0x00h | UNUSED | | HALF_CYCLE_DIVIDER | | | | | | | | | |
| | 0x524h [23:14] | 0x00h | UNUSED | | | | SYNTH_ | SYNTH_NUM | | | | | | |
| | 0x524h [31:24] | 0x00h | UNUSED | | MONO_SYNC_WIDTH | | | SYNC_RATE | | | | | | |
| | 0x525h [7:0] | 0x00h | TX_BIT | | | | TX_WIDTH | RX_WIDTH | | | | | | |
| | 0x525h [15:8] | 0x02h | RX_ | RX_ | RX_MSB_POSITION | | | RX_MODE | | | | | | |
| | 0x525h [23:16] | 0x02h | TX_ | TX_ | TX_MSB_POSITION | | TX_MODE | | | | | | | |
| | 0x525h [31:24] | 0x00h | UNUSED | | | | | | | | | | | |
| ADC TRIM CO-EFFECTIVE | 0x526h [7:0] | 0x00h | ADC_COMP_COEFF_C0 [7:0] | | | | | | | | | | | |
| | 0x526h [15:8] | 0x00h | ADC_COMP_COEFF_C0 [15:8] | | | | | | | | | | | |
| | 0x526h [23:14] | 0x00h | ADC_COMP_COEFF_C1 [7:0] | | | | | | | | | | | |
| | 0x526h [31:24] | 0x00h | ADC_COMP_COEFF_C1 [15:8] | | | | | | | | | | | |
| | 0x527h [7:0] | 0x00h | ADC_COMP_COEFF_C2 [7:0] | | | | | | | | | | | |
| | 0x527h [15:8] | 0x00h | ADC_COMP_COEFF_C2 [15:8] | | | | | | | | | | | |
| READBACK (READ-ONLY) | 0x528h [7:0] | 0x00h | UNUSED | I2SL_LVL | I2SR_LVL | ADCL_LVL | ADCR_LVL | ADCL_ | ADCR_ | | | | | |
| | | | | CLIP | CLIP | CLIP | CLIP | CLIP | CLIP | | | | | |
| | 0x528h [15:8] | 0x00h | UNUSED | | THERMAL | SHORT4 | SHORT3 | SHORT2 | SHORT1 | | | | | |
| | 0x528h [23:14] | 0x00h | SPARE | | | | | | | | | | | |
| READBACK (READ-ONLY) | 0x528h [31:24] | 0x00h | UNUSED | | | | | | | | | | | |
| | 0x529h [7:0] | 0x00h | UNUSED | | | | CE_STATE | | | | | | | |
| | 0x529h [15:8] | 0x00h | SPARE | | | | | | | | | | | |
| | 0x529h [23:14] | 0x00h | UNUSED | | | | | | | | | | | |
| | 0x529h [31:24] | 0x00h | UNUSED | | | | | | | | | | | |

FILTER CONTROL REGISTER (0x500h)

Configures the LM48901 Array and Pre-Array filters (Spatial Engine). The Filter Control Register sets the length of the Array and Pre-Array filter taps, and selects the filter channel source for each audio output. Set PRE_BYPASS and ARRAY_BYPASS to 1 to bypass the Spatial Engine, disabling the spatial effect without modifying the coefficients. Set PRE_ENABLE and ARRAY_ENABLE to 1 to enable the Spatial Engine. Set PRE_ENABLE and ARRAY_ENABLE to 0 to disable the spatial engine. Disabling the Spatial Engine does not affect the register contents. Disable the Spatial Engine during coefficient programming.

Table 5. Filter Control Register

| BIT | NAME | VALUE | DESCRIPTION |
|------|-----------|-------|--|
| 7:0 | ARRAY_TAP | | Array Filter Tap Length |
| 14:8 | PRE_TAP | | Pre-filter Tap Length. Pre-filter tap length should be less than or equal to the Array filter tap length |
| 15 | UNUSED | | |

Table 5. Filter Control Register (continued)

| BIT | NAME | VALUE | DESCRIPTION |
|-------|--------------|-------|---|
| 17:16 | CH1_SEL | | Channel 1 Output Routing Selection |
| | | 00 | Array Filter Channel 0 Output Select |
| | | 01 | Array Filter Channel 1 Output Select |
| | | 10 | Array Filter Channel 2 Output Select |
| | | 11 | Array Filter Channel 3 Output Select |
| 19:18 | CH2_SEL | | Channel 2 Output Routing Selection |
| | | 00 | Array Filter Channel 0 Output Select |
| | | 01 | Array Filter Channel 1 Output Select |
| | | 10 | Array Filter Channel 2 Output Select |
| | | 11 | Array Filter Channel 3 Output Select |
| 21:20 | CH3_SEL | | Channel 3 Output Routing Selection |
| | | 00 | Array Filter Channel 0 Output Select |
| | | 01 | Array Filter Channel 1 Output Select |
| | | 10 | Array Filter Channel 2 Output Select |
| | | 11 | Array Filter Channel 3 Output Select |
| 23:22 | CH4_SEL | | Channel 4 Output Routing Selection |
| | | 00 | Array Filter Channel 0 Output Select |
| | | 01 | Array Filter Channel 1 Output Select |
| | | 10 | Array Filter Channel 2 Output Select |
| | | 11 | Array Filter Channel 3 Output Select |
| 27:24 | UNUSED | | |
| 28 | PRE_BYPASS | 0 | Pre-Array filter not bypassed |
| | | 1 | Pre-Array filter bypassed |
| 29 | ARRAY_BYPASS | 0 | Array filter not bypassed |
| | | 1 | Array filter bypassed |
| 30 | PRE_ENABLE | 0 | Pre-Array filter disabled. Disable the Pre-Array Filter during filter and coefficient programming. Disabling the Pre-Array Filter does not affect the device memory contents. |
| | | 1 | Pre-Array filter enabled |
| 31 | ARRAY_ENABLE | 0 | Array filter disabled. Disable the Array Filter during filter and coefficient programming. Disabling the Array Filter does not affect the device memory contents. |
| | | 1 | Array filter enabled |

COMPRESSOR CONTROL REGISTER 1 (FILTER COMP1) (0x501h)**Table 6. Compressor Control Register**

| BIT | NAME | VALUE | DESCRIPTION |
|-----|---------|-------|---------------------------------|
| 4:0 | COMP_TH | | Pre-Filter Compressor Threshold |
| | | 00000 | 0 |
| | | 00001 | 0.3125 |
| | | 00010 | 0.0625 |
| | | - | - |
| | | 10000 | 0.5 |
| | | - | - |
| | | 11000 | 0.75 |
| | | - | - |
| | | 11111 | 0.96875 |

Table 6. Compressor Control Register (continued)

| BIT | NAME | VALUE | DESCRIPTION |
|-------|-------------------|-------|--|
| 7:5 | G1_GAIN | | Pre-Compression Gain (V/V) |
| | | 000 | 2 |
| | | 001 | 4 |
| | | 010 | 8 |
| | | 011 | 16 |
| | | 100 | 32 |
| | | 101 | 64 |
| | | 110 | 128 |
| | | 111 | 256 |
| 10:8 | COMP_RATIO | | Compression Ratio |
| | | 000 | 1:1 |
| | | 001 | 2:1 |
| | | 010 | 2.66:1 |
| | | 011 | 4:1 |
| | | 100 | 5.33:1 |
| | | 101 | 8:1 |
| | | 110 | 10.66:1 |
| | | 111 | 16:1 |
| 11 | UNUSED | | |
| 14:12 | POST_GAIN | | Post Compression Gain (V/V) |
| | | 000 | 1 |
| | | 001 | 1.25 |
| | | 010 | 1.5 |
| | | 011 | 2 |
| | | 100 | 2.5 |
| | | 101 | 3 |
| | | 110 | 4 |
| | | 111 | 8 |
| 15 | UNUSED | | |
| 23:16 | ARRAY_COMP_SELECT | | Array Filter Compression Control Register Select. The Array Filter has four channels, each channel can choose one of two Array Filter Compression Threshold, Pre-Compression Gain, Compression Ratio, and Post Compression Gain settings from the FILTER_COMP2 register Table 4. |
| | | 0000 | Select Setting 0 |
| | | - | - |
| | | 1111 | Select Setting 1 |
| 31:24 | UNUSED | | |

COMPRESSOR CONTROL REGISTER 2 (FILTER COMP2) (0x502h)

Table 7. Compressor Control Register 2

| BIT | NAME | VALUE | DESCRIPTION |
|-------|------------|-------|---|
| 4:0 | COMP_TH | | Array Filter Compressor Threshold (Setting 0) |
| | | 00000 | 0 |
| | | 00001 | 0.03125 |
| | | 00010 | 0.0325 |
| | | - | - |
| | | 10000 | 0.5 |
| | | - | - |
| | | 11000 | 0.75 |
| | | - | - |
| | | 11111 | 0.96875 |
| 7:5 | G1_GAIN | | Pre-Compression Gain (V/V) (Setting 0) |
| | | 000 | 2 |
| | | 001 | 4 |
| | | 010 | 8 |
| | | 011 | 16 |
| | | 100 | 32 |
| | | 101 | 64 |
| | | 110 | 128 |
| | | 111 | 256 |
| 10:8 | COMP_RATIO | | Compression Ratio (Setting 0) |
| | | 000 | 1:1 |
| | | 001 | 2:1 |
| | | 010 | 2.66:1 |
| | | 011 | 4:1 |
| | | 100 | 5.33:1 |
| | | 101 | 8:1 |
| | | 110 | 10.66:1 |
| | | 111 | 16:1 |
| 11 | UNUSED | | |
| 14:12 | POST_GAIN | | Post Compression Gain (V/V) (Setting 0) |
| | | 000 | 1 |
| | | 001 | 1.25 |
| | | 010 | 1.5 |
| | | 011 | 2 |
| | | 100 | 2.5 |
| | | 101 | 3 |
| | | 110 | 4 |
| 15 | UNUSED | | |

Table 7. Compressor Control Register 2 (continued)

| BIT | NAME | VALUE | DESCRIPTION |
|-------|------------|-------|---|
| 20:16 | COMP_TH | | Pre-Filter Compressor Threshold (Setting 1) |
| | | 00000 | 0 |
| | | 00001 | 0.03125 |
| | | 00010 | 0.0325 |
| | | - | - |
| | | 10000 | 0.5 |
| | | - | - |
| | | 11000 | 0.75 |
| | | - | - |
| | | 11111 | 0.96875 |
| 23:21 | G1_GAIN | | Pre-Compression Gain (V/V) (Setting 1) |
| | | 000 | 2 |
| | | 001 | 4 |
| | | 010 | 8 |
| | | 011 | 16 |
| | | 100 | 32 |
| | | 101 | 64 |
| | | 110 | 128 |
| | | 111 | 256 |
| | | | Compression Ratio (Setting 1) |
| 24:26 | COMP_RATIO | 000 | 1:1 |
| | | 001 | 2:1 |
| | | 010 | 2.66:1 |
| | | 011 | 4:1 |
| | | 100 | 5.33:1 |
| | | 101 | 8:1 |
| | | 110 | 10.66:1 |
| | | 111 | 16:1 |
| 27 | UNUSED | | |
| 30:28 | POST_GAIN | | Post Compression Gain (V/V) (Setting 1) |
| | | 000 | 1 |
| | | 001 | 1.25 |
| | | 010 | 1.5 |
| | | 011 | 2 |
| | | 100 | 2.5 |
| | | 101 | 3 |
| | | 110 | 4 |
| | | 111 | 8 |
| 31 | UNUSED | | |

FILTER DEBUG REGISTER 1 (FILT_DBG1) (0x504h)
Table 8. Filter Debug Register 1

| BIT | NAME | VALUE | DESCRIPTION |
|-----|---------------|-------|--|
| 3:0 | ACC_ADDR | | Accumulator Address. Selects which accumulator is read during debug mode |
| 4 | FILTER_SELECT | 0 | Selects Pre-Filter Accumulators |
| | | 1 | Selects Array Filter Accumulators |

Table 8. Filter Debug Register 1 (continued)

| BIT | NAME | VALUE | DESCRIPTION |
|------|-------------|-------|--|
| 5 | UNUSED | | |
| 6 | STEP_ENABLE | 0 | Single Step Disabled |
| | | 1 | Single Step Enabled |
| 7 | DBG_ENABLE | 0 | Debug Mode Disabled. Coefficient memory is inaccessible with Debug mode is disabled. |
| | | 1 | Debug Mode Enabled. Coefficient memory is accessible when Debug mode is enabled. |
| 31:8 | UNUSED | | |

FILTER STATISTICS CONTROL REGISTER (FILT_STC) (0x505h)**Table 9. Filter Statistics Control Register**

| BIT | NAME | VALUE | DESCRIPTION |
|--------------------|-------------|-------|---|
| PRE-FILTER Counter | | | |
| 3:0 | CH_SEL | | Channel Select |
| | | 000 | Channel 0 |
| | | 001 | Channel 1 |
| | | 010 | Channel 2 |
| | | 011 | Channel 3 |
| | | 100 | Channel 4 |
| | | 101 | Channel 5 |
| | | 110 | Channel 6 |
| | | 111 | Channel 7 |
| 7:4 | COUNT1_MODE | | Counter 1 Mode Select. Specifies input of Counter 1 |
| | | 0000 | Sample Count Mode. Every audio sample is counted |
| | | 0001 | Overflow. Overflow events counted |
| | | 0010 | Frequency Error. Indicates input frequency not sufficient for given filter length |
| | | 1000 | MAGN[7] |
| | | 1001 | MAGN[7:6] |
| | | 1010 | MAGN[7:5] |
| | | 1011 | MAGN[7:4] |
| | | 1100 | MAGN[7:3] |
| | | 1101 | MAGN[7:2] |
| | | 1110 | MAGN[7:1] |
| | | 1111 | MAGN[7:0] |
| | | | Counter 2 Mode Select. Specifies input of Counter 2 |
| | | 0000 | Sample Count Mode. Every audio sample is counted |
| | | 0001 | Overflow. Overflow events counted |
| 11:8 | COUNT2_MODE | | Frequency Error. Indicates input frequency not sufficient for given filter length |
| | | 0010 | MAGN[7] |
| | | 1000 | MAGN[7:6] |
| | | 1001 | MAGN[7:5] |
| | | 1010 | MAGN[7:4] |
| | | 1100 | MAGN[7:3] |
| | | 1101 | MAGN[7:2] |
| | | 1110 | MAGN[7:1] |
| | | 1111 | MAGN[7:0] |

Table 9. Filter Statistics Control Register (continued)

| BIT | NAME | VALUE | DESCRIPTION |
|----------------------|-------------|-------|---|
| 14:12 | UNUSED | | |
| | | 0 | Counter Enabled |
| 15 | CLEAR | 1 | Counter Cleared |
| ARRAY-FILTER Counter | | | |
| 19:16 | CH_SEL | | Channel Select |
| | | 000 | Channel 0 |
| | | 001 | Channel 1 |
| | | 010 | Channel 2 |
| | | 011 | Channel 3 |
| | | 100 | Channel 4 |
| | | 101 | Channel 5 |
| | | 110 | Channel 6 |
| | | 111 | Channel 7 |
| 23:20 | COUNT1_MODE | | Counter 1 Mode Select. Specifies input of Counter 1 |
| | | 0000 | Sample Count Mode. Every audio sample is counted |
| | | 0001 | Overflow. Overflow events counted |
| | | 0010 | Frequency Error. Indicates input frequency not sufficient for given filter length |
| | | 1000 | MAGN[7] |
| | | 1001 | MAGN[7:6] |
| | | 1010 | MAGN[7:5] |
| | | 1011 | MAGN[7:4] |
| | | 1100 | MAGN[7:3] |
| | | 1101 | MAGN[7:2] |
| | | 1110 | MAGN[7:1] |
| | | 1111 | MAGN[7:0] |
| 27:24 | COUNT2_MODE | | Counter 2 Mode Select. Specifies input of Counter 2 |
| | | 0000 | Sample Count Mode. Every audio sample is counted |
| | | 0001 | Overflow. Overflow events counted |
| | | 0010 | Frequency Error. Indicates input frequency not sufficient for given filter length |
| | | 1000 | MAGN[7] |
| | | 1001 | MAGN[7:6] |
| | | 1010 | MAGN[7:5] |
| | | 1011 | MAGN[7:4] |
| | | 1100 | MAGN[7:3] |
| | | 1101 | MAGN[7:2] |
| | | 1110 | MAGN[7:1] |
| | | 1111 | MAGN[7:0] |
| 30:28 | UNUSED | | |
| 31 | CLEAR | 0 | Counter Enabled |
| | | 1 | Counter Cleared |

DELAY REGISTER (DELAY) (0x520h)
Table 10. Delay Register

| BIT | NAME | VALUE | DESCRIPTION |
|------|----------------|-------|--|
| 15:0 | POWER_UP_DELAY | | Sets I2C Delay Time. Default 10ms delay. |

Table 10. Delay Register (continued)

| BIT | NAME | VALUE | DESCRIPTION |
|-------|----------------|-------|---|
| 23:16 | DEGLITCH_DELAY | | Sets ENABLE Bit Polling Timeout. Default 32ms delay |
| 31:24 | STATE_DELAY | | Sets Delay Between Power Up/Down States |

ENABLE AND CLOCK CONFIGURATION REGISTER (ENABLE & CLOCKS) (0x521h)**Table 11. Enable and Clock Configuration Register**

| BIT | NAME | VALUE | DESCRIPTION |
|-------|----------------------|-------|--|
| 0 | ENABLE | 0 | Device Disabled in I ² C Mode |
| | | 1 | Device Enabled in I ² C Mode |
| 1 | FORCE | 0 | Device Enabled Via SHDN <> Pin |
| | | 1 | Device Enabled Via I ² C |
| 2 | PULSE | 0 | SHDN<> Requires a Stable Logic Level |
| | | 1 | SHDN<> Accepts a Pulse Input |
| 3 | RELY_ON_VREF | 0 | Device waits for delay time determined by STATE_DELAY to enable. |
| | | 1 | Device waits for stable VREF |
| 7:4 | UNUSED | | |
| 10:8 | MCLK_RATE | | Selects PLL Input Divider |
| | | 000 | 32fs (1.536MHz) |
| | | 001 | 64fs (3.072MHz) |
| | | 010 | 128fs (6.114MHz) |
| | | 011 | 256fs (12.288MHz) |
| | | 100 | 512fs (24.576MHz) |
| | | 101 | UNUSED |
| | | 110 | UNUSED |
| | | 111 | UNUSED |
| 11 | I ² S_CLK | 0 | MCLK Input to PLL |
| | | 1 | I ² S_CLK Input to PLL |
| 12 | PMC_CLK_SEL | 0 | Oscillator Clock Input to Power Management Circuitry |
| | | 1 | External Clock to Power Management Circuitry. Power management circuit uses MCLK or I ² S_CLK. Clock source depends on the state of I ² S_CLK. External Clock mode disables the internal oscillator. |
| 13 | HIFI | 0 | HiFi Mode Disabled |
| | | 1 | HiFi Mode Enabled. PLL always produces a 4096fs clock. |
| 14 | QSA_CLK_STOP | 0 | QSA Clock Enabled |
| | | 1 | QSA Clock Disabled Following Device Configuration |
| 15 | UNUSED | | |
| 16 | ADC_SYNC_SEL | 0 | Normal Operation |
| | | 1 | Reverse ADC SYNC Signal for additional timing margin at low supply voltages. |
| 31:17 | UNUSED | | |

DIGITAL MIXER CONTROL REGISTER (DIGITAL MIXER) (0x522h)
Table 12. Digital Mixer Control Register

| BIT | NAME | VALUE | DESCRIPTION |
|-------|----------------------|--------|--|
| 5:0 | ADC_LVL | | Sets the Gain of the ADC Path (dB) |
| | | 000000 | -76.5 |
| | | 000001 | -75 |
| | | - | 1.5dB steps |
| | | 110010 | -1.5 |
| | | 110011 | 0 |
| | | 110100 | 1.5 |
| | | - | 1.5dB Steps |
| | | 111111 | 18 |
| 6 | MUTE | 0 | Normal Operation |
| | | 1 | Mute |
| 7 | ZXD_DISABLE | 0 | Zero Crossing Detection Enabled |
| | | 1 | Zero Crossing Detection Disabled |
| 13:8 | I ² S_LVL | | Sets the Gain of the I ² S Path (dB) |
| | | 000000 | -76.5 |
| | | 000001 | -75 |
| | | - | 1.5dB steps |
| | | 110010 | -1.5 |
| | | 110011 | 0 (V _{OUT} = 3.36V _{RMS} with 0dBFS input) |
| | | 110100 | 1.5 |
| | | - | 1.5dB Steps |
| | | 111111 | 18 |
| 15:14 | UNUSED | | |
| 16 | I ² S_DSP | 0 | I ² S Data Not Passed to DSP |
| | | 1 | I ² S Data Passed to DSP |
| 17 | ADC_DSP | 0 | ADC Output Not Passed to DSP |
| | | 1 | ADC Output Passed to DSP |
| 19:18 | ISA_TX_SEL | | Selects Input of Primary I ² S Transmitter |
| | | 00 | None |
| | | 01 | ADC |
| | | 10 | DSP1/2 |
| | | 11 | DSP3/4 |
| 21:20 | ISB_TX_SEL | | Selects Input of Secondary I ² S Transmitter |
| | | 00 | None |
| | | 01 | ADC |
| | | 10 | DSP1/2 |
| | | 11 | DSP3/4 |
| 22 | I ² SA_ON | 0 | I ² SA Data NOT Output on <u>SHDN</u> |
| | | 1 | I ² SA Data Output on <u>SHDN</u> |
| 23 | I ² SB_ON | 0 | I ² SB Data NOT Output on <u>SHDN</u> |
| | | 1 | I ² SB Data Output on <u>SHDN</u> |

Table 12. Digital Mixer Control Register (continued)

| BIT | NAME | VALUE | DESCRIPTION |
|-------|----------|-------|-------------------------------------|
| 25:24 | OUT1_SEL | | Selects OUT1 Amplifier Input Source |
| | | 00 | OUT1 Disabled |
| | | 01 | DSP |
| | | 10 | I2S |
| | | 11 | ADC |
| 27:26 | OUT2_SEL | | Selects OUT2 Amplifier Input Source |
| | | 00 | OUT2 Disabled |
| | | 01 | DSP |
| | | 10 | I2S |
| | | 11 | ADC |
| 29:28 | OUT3_SEL | | Selects OUT3 Amplifier Input Source |
| | | 00 | OUT3 Disabled |
| | | 01 | DSP |
| | | 10 | I2S |
| | | 11 | ADC |
| 31:30 | OUT4_SEL | | Selects OUT4 Amplifier Input Source |
| | | 00 | OUT4 Disabled |
| | | 01 | DSP |
| | | 10 | I2S |
| | | 11 | ADC |

ANALOG CONFIGURATION REGISTER (ANALOG) (0x523h)**Table 13. Analog Configuration Register**

| BIT | NAME | VALUE | DESCRIPTION |
|-----|------------|-------|--|
| 1:0 | ANA_LVL | | Sets ADC Preamplifier Gain (dB) |
| | | 00 | 0 |
| | | 01 | 2.4 |
| | | 10 | 3.5 |
| | | 11 | 6 |
| 2 | PARALLEL | 0 | Normal Operation. OUT2 and OUT3 operate as separate amplifiers. |
| | | 1 | Parallel Operation. OUT2 and OUT3 operate in parallel as a single amplifier. |
| 3 | ZERO_ANA | 0 | Normal Operation |
| | | 1 | Auto-Shutdown Mode. Automatically disables the amplifiers when no analog input is detected. |
| 4 | ZERO_DIG | 0 | Normal Operation |
| | | 1 | Auto-Shutdown Mode. Automatically disables the amplifiers when there is no I2S input. |
| 5 | ADCTRIM | 0 | ADC Trim Disabled |
| | | 1 | ADC Trim Enabled. Use ADC_COMP_COEFF_C0-C2 to trim ADC. |
| 6 | AUTO_SD | 0 | Normal Operation |
| | | 1 | Fault Conditions Disable the Amplifiers |
| 7 | BYPASS_MOD | 0 | Normal Operation |
| | | 1 | Pulse Correction Bypass. Amplifier output stages act as a buffer, passing PWM signal without correction to output. |

Table 13. Analog Configuration Register (continued)

| BIT | NAME | VALUE | DESCRIPTION |
|-------|----------|-------|--|
| 8 | TST_SHT | 0 | Normal Operation |
| | | 1 | Short Amplifier Inputs. Sets amplifier outputs to 50% duty cycle, minimizing click and pop during power up/down. |
| 9 | SCKT_DIS | 0 | Normal Operation |
| | | 1 | Output Short Circuit Protection Disabled |
| 10 | TSD_DIS | 0 | Normal Operation |
| | | 1 | Thermal Shutdown Disabled |
| 11 | PMC_TEST | 0 | Normal Operation |
| | | 1 | PMC uses PLL Source Clock |
| 12 | SE_MOD | 0 | Normal Operation |
| | | 1 | Single Edge Modulation Mode |
| 31:13 | UNUSED | | |

I²S PORT CONFIGURATION REGISTER (I²S PORT) (0x524h/0x525h)

| BIT | NAME | VALUE | DESCRIPTION |
|---------------|--------------------|--------|--|
| 0x524h | | | |
| 0 | STEREO | 0 | Mono Mode |
| | | 1 | Stereo Mode |
| 1 | RX_ENABLE | 0 | Receive Mode Disabled |
| | | 1 | Receive Mode Enabled |
| 2 | TX_ENABLE | 0 | Transmit Mode Disabled |
| | | 1 | Transmit Mode Enabled |
| 3 | CLK_MS | 0 | I2S Clock Slave. Device requires an external SCLK for proper operation. |
| | | 1 | I2S Clock Master. Device generates SCLK and transmits when either RX or TX mode are enabled. |
| 4 | SYNC_MS | 0 | I2S WS Slave. Device requires an external WS for proper operation. |
| | | 1 | I2S WS Master. Device generates WS and transmits when either RX or TX mode are enabled. |
| 5 | CLOCK_PHASE | 0 | I2S Clock Phase. Transmit on falling edge, receive on rising edge. |
| | | 1 | PCM Clock Phase. Transmit on rising edge, receive on falling edge. |
| 6 | STEREO_SYNC_PHASE | 0 | I2S Data Format: Left, Right |
| | | 1 | I2S Data Format: Right, Left |
| 7 | SYNC_MODE | Mono | Rising edge indicates start of data word. |
| | | 0 | SYNC low = Left, SYNC high = Right |
| | | 1 | SYNC low = Right, SYNC high = left |
| 13:8 | HALF_CYCLE_DIVIDER | | Configures the I2S port master clock half-cycle divider. Program the half-cycle divider by: (ReqDiv*2) 1 |
| | | 000000 | BYPASS |
| | | 000001 | 1 |
| | | 000010 | 1.5 |
| | | 000011 | 2 |
| | | - | - |
| | | 111101 | 31 |
| | | 111110 | 31.5 |
| | | 111111 | 32 |

| BIT | NAME | VALUE | DESCRIPTION |
|--------|-----------------|-------|--|
| 15:14 | UNUSED | | |
| 18:16 | SYNTH_NUM | | Sets the Clock Generator Numberator |
| | | 000 | SYNTH_DENOM (1/) |
| | | 001 | 100/SYNTH_DENOM |
| | | 010 | 96/SYNTH_DENOM |
| | | 011 | 80/SYNTH_DENOM |
| | | 100 | 72/SYNTH_DENOM |
| | | 101 | 64/SYNTH_DENOM |
| | | 110 | 48/SYNTH_DENOM |
| | | 111 | 0/SYNTH_DENOM |
| 19 | SYNTH_DENOM | 0 | Clock Generator Denominator = 128 |
| | | 1 | Clock Generator Denominator = 125 |
| 23:20 | UNUSED | | |
| 26:24 | SYNC_RATE | | Sets number of clock cycles before SYNC pattern repeats. |
| | | | MONO MODE |
| | | 000 | 8 |
| | | 001 | 12 |
| | | 010 | 16 |
| | | 011 | 18 |
| | | 100 | 20 |
| | | 101 | 24 |
| | | 110 | 25 |
| | | 111 | 32 |
| | | | STEREO MODE |
| | | 000 | 16 |
| | | 01 | 24 |
| | | 010 | 32 |
| | | 011 | 36 |
| | | 100 | 40 |
| | | 101 | 48 |
| | | 110 | 50 |
| | | 111 | 64 |
| 29:27 | MONO_SYNC_WIDTH | | Sets SYNC symbol width in Mono Mode |
| | | 000 | 1 |
| | | 001 | 2 |
| | | 010 | 4 |
| | | 011 | 7 |
| | | 100 | 8 |
| | | 101 | 11 |
| | | 110 | 15 |
| | | 111 | 16 |
| 31:30 | UNUSED | | |
| 0x525h | | | |

| BIT | NAME | VALUE | DESCRIPTION |
|-----|----------|-------|--|
| 2:0 | RX_WIDTH | | Sets number of valid RECEIVE bits. |
| | | 000 | 24 |
| | | 001 | 20 |
| | | 010 | 18 |
| | | 011 | 16 |
| | | 100 | 14 |
| | | 101 | 13 |
| | | 110 | 12 |
| | | 111 | 8 |
| 5:3 | TX_WIDTH | | Sets number of TRANSMIT bits. |
| | | 000 | 24 |
| | | 001 | 20 |
| | | 010 | 18 |
| | | 011 | 16 |
| | | 100 | 14 |
| | | 101 | 13 |
| | | 110 | 12 |
| | | 111 | 8 |
| 7:6 | TX_BIT | | Sets number of pad bits after the valid Transmit bits. |
| | | 00 | 0 |
| | | 01 | 1 |
| | | 10 | High-Z |
| | | 11 | High-Z |
| 8 | RX_MODE | 0 | MSB Justified Receive Mode |
| | | 1 | LSB Justified Receive Mode |

| BIT | NAME | VALUE | DESCRIPTION |
|------|-----------------|-------|--|
| 13:9 | RX_MSB_POSITION | | MSB location from the frame start (MSB Justified) or LSB location from the frame end (LSB Justified) |
| | | 00000 | 0 (DSP/PCM LONG) |
| | | 00001 | 1 (I2S/PCM SHORT) |
| | | 00010 | 2 |
| | | 00011 | 3 |
| | | 00100 | 4 |
| | | 00101 | 5 |
| | | 00110 | 6 |
| | | 00111 | 7 |
| | | 01000 | 8 |
| | | 01001 | 9 |
| | | 01010 | 10 |
| | | 01011 | 11 |
| | | 01100 | 12 |
| | | 01101 | 13 |
| | | 01110 | 14 |
| | | 01111 | 15 |
| | | 10000 | 16 |
| | | 10001 | 17 |
| | | 10010 | 18 |
| | | 10011 | 19 |
| | | 10100 | 20 |
| | | 10101 | 21 |
| | | 10110 | 22 |
| | | 10111 | 23 |
| | | 11000 | 24 |
| | | 11001 | 25 |
| | | 11010 | 26 |
| | | 11011 | 27 |
| | | 11100 | 28 |
| | | 11101 | 29 |
| | | 11110 | 30 |
| | | 11111 | 31 |
| 14 | RX_COMPAND | 0 | Normal Operation |
| | | 1 | Audio Data Companded |
| 15 | RX_A/μLAW | 0 | μLaw Compand Mode |
| | | 1 | A-Law Compand Mode |
| 16 | TX_MODE | 0 | MSB Justified Transmit Mode |
| | | 1 | LSB Justified Transmit Mode |

| BIT | NAME | VALUE | DESCRIPTION |
|-------|-----------------|-------|--|
| 21:17 | TX_MSB_POSITION | | MSB location from the frame start (MSB Justified) or LSB location from the frame end (LSB Justified) |
| | | 00000 | 0 (DSP/PCM LONG) |
| | | 00001 | 1 (I2S/PCM SHORT) |
| | | 00010 | 2 |
| | | 00011 | 3 |
| | | 00100 | 4 |
| | | 00101 | 5 |
| | | 00110 | 6 |
| | | 00111 | 7 |
| | | 01000 | 8 |
| | | 01001 | 9 |
| | | 01010 | 10 |
| | | 01011 | 11 |
| | | 01100 | 12 |
| | | 01101 | 13 |
| | | 01110 | 14 |
| | | 01111 | 15 |
| | | 10000 | 16 |
| | | 10001 | 17 |
| | | 10010 | 18 |
| | | 10011 | 19 |
| | | 10100 | 20 |
| | | 10101 | 21 |
| | | 10110 | 22 |
| | | 10111 | 23 |
| | | 11000 | 24 |
| | | 11001 | 25 |
| | | 11010 | 26 |
| | | 11011 | 27 |
| | | 11100 | 28 |
| | | 11101 | 29 |
| | | 11110 | 30 |
| | | 11111 | 31 |
| 22 | TX_COMPAND | 0 | Normal Operation |
| | | 1 | Audio Data Compressed |
| 23 | TX_A/ μ LAW | 0 | μ Law Compress Mode |
| | | 1 | A-Law Compress Mode |
| 31:24 | UNUSED | | |

ADC TRIM COEFFICIENT REGISTER (ADC_TRIM) (0x526h/0x527)

Table 14. ADC Trim Coefficient Register

| BIT | NAME | VALUE | DESCRIPTION |
|--------|-------------------|-------|------------------------------|
| 0x526h | | | |
| 15:0 | ADC_COMP_COEFF_C0 | | Sets ADC Trim Coefficient C0 |
| 31:16 | ADC_COMP_COEFF_C1 | | Sets ADC Trim Coefficient C1 |
| 0x527h | | | |
| 15:0 | ADC_COMP_COEFF_C2 | | Sets ADC Trim Coefficient C2 |

READBACK REGISTER (READBACK) (0x528h) READ-ONLY

Table 15. Readback Register

| BIT | NAME | VALUE | DESCRIPTION |
|-------|--------------|-------|-------------------------------------|
| 0 | ADCR_CLIP | 1 | Right Channel ADC Input Clipped |
| 1 | ADCL_CLIP | 1 | Left Channel ADC Input Clipped |
| 2 | ADCR_LVLCLIP | 1 | Right Channel ADC Output Clipped |
| 3 | ADCL_LVLCLIP | 1 | Left Channel ADC Output Clipped |
| 4 | I2SR_LVLCLIP | 1 | Right Channel I2S Output Clipped |
| 5 | I2SL_LVLCLIP | 1 | Left Channel I2S Output Clipped |
| 7:6 | UNUSED | | |
| 8 | SHORT1 | 1 | OUT1 Output Short Circuit |
| 9 | SHORT2 | 1 | OUT2 Output Short Circuit |
| 10 | SHORT3 | 1 | OUT3 Output Short Circuit |
| 11 | SHORT4 | 1 | OUT4 Output Short Circuit |
| 12 | THERMAL | 1 | Thermal Shutdown Threshold Exceeded |
| 23:13 | SPARE | | |
| 31:24 | UNUSED | | |

SYSTEM CONFIGURATION REGISTER (SYS_CONFIG) (0x530h)

Table 16. System Configuration Register

| BIT | NAME | VALUE | DESCRIPTION |
|-------|-------------------|-------|---|
| 6:0 | DEVICE_ID | | Sets LM48901 Device ID in slave mode |
| 7 | CONFIG_CLK_ENABLE | 0 | Configuration Loader Clock Disabled |
| | | 1 | Configuration Loader Clock Enabled |
| 14:8 | ALT_DEVICE_ID | | Sets Alternate Device ID in Slave Mode. |
| 15 | ALTID_ENABLE | 0 | Selects DEVICE_ID |
| | | 1 | Selects ALT_DEVICE_ID |
| 16 | CL_REQ | 0 | Configuration Loader Access not Requested |
| | | 1 | Configuration Loader Access Requested. I2C Master Transaction Enabled |
| 17 | CL_W | 0 | Configuration Loader Set to READ-ONLY |
| | | 1 | Configuration Loader Set to WRITE |
| 20:18 | CL_PAGE | | Sets I2C Page Mode Length |
| | | 00 | Single Byte |
| | | 01 | 4 Bytes |
| | | 10 | 8 Bytes |
| | | 11 | 16 Bytes |
| 22:21 | UNUSED | | |
| 23 | CL_ENABLE | 0 | Device Configured as I2C Slave |
| | | 1 | Device Configured as I2C Master |
| 24 | MBIST0_ENABLE | 0 | Memory BIST Controller 0 Disabled |
| | | 1 | Memory BIST Control 0 Enabled. |
| 25 | MBIST1_ENABLE | 0 | Memory BIST Controller 1 Disabled |
| | | 1 | Memory BIST Control 1 Enabled. |
| 31:26 | UNUSED | | |

I²C MASTER CONFIGURATION LOADER REGISTER 0 (CL_REG0) (0x531h)
Table 17. Filter Debug Register 0

| BIT | NAME | VALUE | DESCRIPTION |
|-------|----------------|-------|---|
| 15:0 | TRANS_LENGTH | | Sets I ² C Master Transaction Length |
| 31:16 | REG_START_ADDR | | Starting Address of LM48901 Memory |

I²C MASTER CONFIGURATION LOADER REGISTER 1 (CL_REG1) (0x532h)
Table 18. Filter Debug Register 1

| BIT | NAME | VALUE | DESCRIPTION |
|-------|---------------|-------|--|
| 15:0 | E2_START_ADDR | | Sets EEPROM Address. Indicates EEPROM start address where data is stored |
| 31:16 | UNUSED | | |

EEPROM ADDRESS OFFSET REGISTER (E2_OFFSET) (0x533h)
Table 19. EEPROM Address Offset Register

| BIT | NAME | VALUE | DESCRIPTION |
|------|-----------|-------|------------------------------|
| 5:0 | E2_OFFSET | | EEPROM Address Offset Value. |
| 31:6 | UNUSED | | |

I²C EnXT REGISTER (I²CEnXT) (0x534h)
Table 20. I²C EnXT Register

| BIT | NAME | VALUE | DESCRIPTION |
|------|--------------|-------|--|
| 5:0 | E2NXT_OFFSET | | Sets EEPROM Address Offset for Following LM48901 when devices are Daisy Chained. |
| 6 | UNUSED | | |
| 7 | I2C_EnXT | 0 | Next Device in Daisy Chain Disabled. I ² C_EX driven Low. |
| | | 1 | Next Device in Daisy Chain Enabled. I ² C_EX driven HIGH. |
| 31:8 | UNUSED | | |

READ-ONLY MBIST STATUS REGISTER (MBIST_STAT) (0x538h)
Table 21. MBIST Status Register

| BIT | NAME | VALUE | DESCRIPTION |
|------|------------|-------|--|
| 1:0 | MBIST_DONE | | Logic HIGH indicates memory test complete |
| 3:2 | BIST_GO | | Logic Low indicates memory fault when MBIST_DONE is HIGH |
| 5:4 | MBIST_EN | 0 | MBIST Read-back Disabled |
| | | 1 | MBIST Read-back Enabled |
| 31:6 | UNUSED | | |

DAISY CHAINING
I²C_EN/I²C_EX

The LM48901 supports daisy chaining up to 127 devices from a single I²C bus utilizing I²C_EN and I²C_EX in a chain enable scheme. I²C_EX is a push/pull logic output that drives the I²C_EN of the following device in the chain [Figure 14](#). At power up, I²C_EnXT (bit 8, I²C_EnXT Register [0x534h]) is set to 0, resulting in I²C_EN driven low, disabling the I²C interface of the following device. Once device configuration is complete, and I²C_EnXT is set to 1, I²C_EN is driven high, enabling the I²C interface of the following device. Driving I²C_EN high enables the device's I²C interface, driving I²C_EN low disables the device's I²C interface.

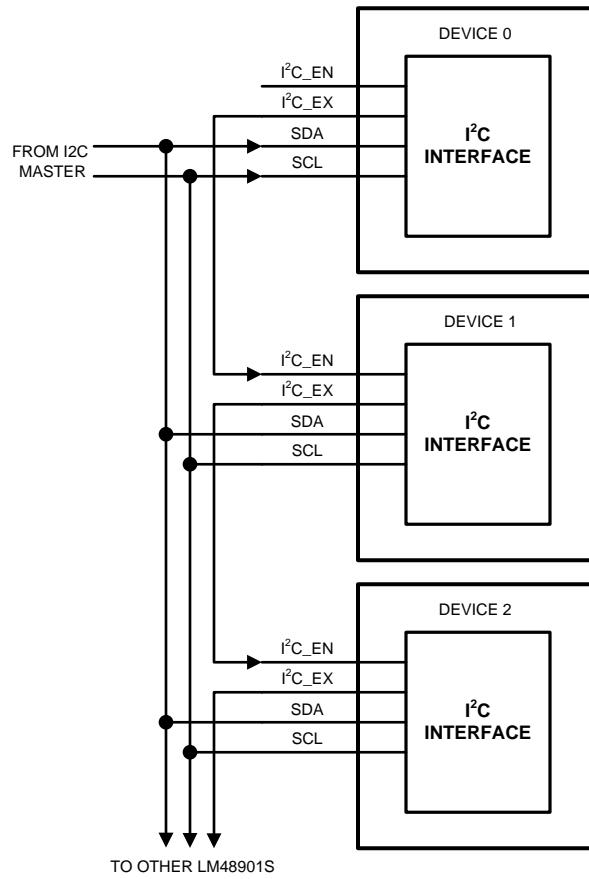


Figure 14. $\text{I}^2\text{C}_{\text{EN}}/\text{I}^2\text{C}_{\text{EX}}$ Daisy Chaining Example

Device Address

The 0110000X is the default LM48901 I^2C address hard coded into the device. Two alternate device addresses can be programmed, via the SYS CONFIG (0x530h) Register. Use the default address during initial device configuration.

GENERAL AMPLIFIER FUNCTION

Class D Amplifier

The LM48901 features four high-efficiency Class D audio power amplifiers that utilizes Texas Instruments' filterless modulation scheme external component count, conserving board space and reducing system cost. The Class D outputs transition from V_{DD} to GND with a 384kHz switching frequency. With no signal applied, the outputs switch with a 50% duty cycle, in phase, causing the two outputs to cancel. This cancellation results in no net voltage across the speaker, thus there is no current to the load in the idle state.

With the input signal applied, the duty cycle (pulse width) of the LM48901 outputs changes. For increasing output voltage, the duty cycle of OUT₊ increases while the duty cycle of OUT₋ decreases. For decreasing output voltages, the converse occurs. The difference between the two pulse widths yield the differential output voltage.

Edge Rate Control (ERC)

The LM48901 features Texas Instruments' advanced edge rate control (ERC) that reduces EMI, while maintaining high quality audio reproduction and efficiency. The LM48901 ERC greatly reduces the high frequency components of the output square waves by controlling the output rise and fall times, slowing the transitions to reduce RF emissions, while maximizing THD+N and efficiency performance. The overall result of the E²S system is a filterless Class D amplifier that passes FCC Class B radiated emissions standards with 24in of twisted pair cable, with excellent 0.06% THD+N and high 89% efficiency.

POWER DISSIPATION AND EFFICIENCY

The major benefit of a Class D amplifier is increased efficiency versus a Class AB. The efficiency of the LM48901 is attributed to the region of operation of the transistors in the output stage. The Class D output stage acts as current steering switches, consuming negligible amounts of power compared to their Class AB counterparts. Most of the power loss associated with the output stage is due to the IR loss of the MOSFET on-resistance, along with switching losses due to gate charge.

ANALOG INPUT

The LM48901 features a differential input, stereo ADC for analog systems. A differential amplifier amplifies the difference between the two input signals. Traditional audio power amplifiers have typically offered only single-ended inputs resulting in a 6dB reduction of SNR relative to differential inputs. The LM48901 also offers the possibility of DC input coupling which eliminates the input coupling capacitors. A major benefit of the fully differential amplifier is the improved common mode rejection ratio (CMRR) over single ended input amplifiers. The increased CMRR of the differential amplifier reduces sensitivity to ground offset related noise injection, especially important in noisy systems.

PARALLEL MODE

In Parallel mode, channels OUT2 and OUT3 are driven from the same audio source, allowing the two channels to be connected in parallel, increasing output power to 3.2W into 4Ω at 10% THD+N. Set bit 2 (PARALLEL) of the Analog Configuration Register (0x532h) = 1 to configured the device in Parallel mode. After the device is set to Parallel mode, make an external connection between OUT2+ and OUT3+, and a connection between OUT2- and OUT3- (Figure 2). In Parallel mode, the combined channels are driven from the OUT2 source. OUT1 and OUT4 are unaffected. Signal routing, mixing, filtering, and equalization are done through the Spatial Engine.

Make sure the device is configured in Parallel mode, before connecting OUT2 and OUT3 and enabling the outputs. Do not make a connection between OUT2 and OUT3 together while the outputs are enabled. Disable the outputs first, then make the connections between OUT2 and OUT3.

GAIN SETTING

The LM48901 has three gain stages, the ADC preamplifier, and two independent volume controls in the Digital Mixer, one for the ADC path and one for the I²S path. The ADC preamplifier has four gain settings (0dB, 2.4dB, 3.5dB, and 6dB). The preamplifier gain is set by bits 0 and 1 (ANA_LVL) of the Analog Configuration Register (0x523h). The Digital Mixer has two 64 step volume controls. The ADC path volume control is set by bits 5:0 (ADC_LVL) in the Digital Mixer Control Register (0x522h). The I²S path volume control is set by bits 13:8 (I²S_LVL) in the Digital Mixer Control Register (0x522h). Both volume controls have a range of -76.5dB to 18dB in 1.5dB increments.

MODULATOR POWER SUPPLY (AV_{DD1})

The AV_{DD1} (R_L package: bump C2, SQ package: pin 12) powers the class D modulators. For maximum output swing, set AV_{DD1} and PV_{DD} to the same voltage. [Table 22](#) shows the output voltage for different AV_{DD1} levels.

Table 22. Amplifier Output Voltage with Variable AV_{DD1} Voltage

| AV _{DD1} (V) | V _{OUT} (V _{RMS}) @ PV _{DD} = 5V, THD+N = 1% | V _{OUT} (V _{RMS}) @ PV _{DD} = 3.6V, THD+N = 1% |
|-----------------------|--|--|
| 5 | 3.3 | - |
| 4.5 | 3.1 | - |
| 4.2 | 2.9 | - |
| 4 | 2.7 | - |
| 3.6 | 2.5 | 2.4 |
| 3.3 | 2.3 | 2.2 |
| 3 | 2.1 | 2.1 |
| 2.8 | 2 | 1.9 |

CLOCK REQUIREMENTS

The LM48901 requires an external clock source for proper operation, regardless of input source or device configuration. The device derives the ADC, digital mixer, DSP, I²S port, and PWM clocks from the external clock. The clock can be derived from either MCLK or SCLK inputs. Set bit 11 (I²S_CLK) of the Enable and Clock configuration register (0x521h) to 0 to select MCLK, set I²S_CLK to 1 to select SCLK. The LM48901 accepts five different clock frequencies, 1.536, 3.072, 6.114, 12.288, and 24.576MHz. Set bits 10:8 (MCLK_RATE) of the Enable and Clock Configuration Register to the appropriate clock frequency. In systems where both MCLK and SCLK are available, choose the lower frequency clock for improved power consumption.

SHUTDOWN FUNCTION

There are two ways to shutdown the LM48901, hardware mode, and software mode. The default is hardware mode.

Set bit 1 (FORCE) of the Enable and Clock Configuration Register (0x521h) to 0 to enable hardware shutdown mode. In hardware mode, the device is enabled and disabled through SHDN. Connect SHDN to V_{DD} for normal operation. Connect SHDN to GND to disable the device. Hardware shutdown mode supports a one shot, or momentary switch SHDN input. When bit 2 (PULSE) of the Enable and Clock Configuration Register (0x521h) is set to 1, the LM48901 responds to a rising edge on SHDN to change the device state. When PULSE = 0, the device requires a stable logic level on SHDN.

Set FORCE = 1 to enable software shutdown mode. In software shutdown mode, the device is enabled and disabled through bit 0 (ENABLE) of the Enable and Clock Configuration Register (0x512h). Set ENABLE = 0 to disable the LM48901. Set ENABLE = 1 to enable the LM48901.

In either hardware or software mode, the content of the LM48901 memory registers is retained after the device is disabled, as long as power is still applied to the device. Minimize power consumption by disabling the PMC clock oscillator when the LM48901 is shutdown. Set bit 12 (PMC_CLK_SEL) and bit 14 (QSA_CLK_STOP) of the Enable and Clock configuration Register (0x521h) = 1 to disable the PMC clock oscillator.

EXTERNAL CAPACITOR SELECTION

Power Supply Bypassing and Filtering

Proper power supply bypassing is critical for low noise performance and high PSRR. Place the supply bypass capacitors as close to the device as possible. Typical applications employ a voltage regulator with 10 μ F and 0.1 μ F bypass capacitors that increase supply stability. These capacitors do not eliminate the need for bypassing of the LM48901 supply pins. A 1 μ F capacitor is recommended for IOV_{DD}, PLLV_{DD}, DV_{DD}, and AV_{DD}. A 2.2 μ F capacitor is recommended for PV_{DD}.

REF and BYPASS Capacitor Selection

For best performance, bypass REF with a 4.7 μ F ceramic capacitor.

INPUT CAPACITOR SELECTION

The LM48901 analog inputs require input coupling capacitors. Input capacitors block the DC component of the audio signal, eliminating any conflict between the DC component of the audio source and the bias voltage of the LM48901. The input capacitors create a high-pass filter with the input resistors R_{IN}. The -3dB point of the high pass filter is found using Equation (1) below.

$$f = 1 / 2\pi R_{IN} C_{IN} \quad (1)$$

Where the value of R_{IN} is 20k Ω .

The input capacitors can also be used to remove low frequency content from the audio signal. Small speakers cannot reproduce, and may even be damaged by low frequencies. High pass filtering the audio signal helps protect the speakers. When the LM48901 is using a single-ended source, power supply noise on the ground is seen as an input signal. Setting the high-pass filter point above the power supply noise frequencies, 217Hz in a GSM phone, for example, filters out the noise such that it is not amplified and heard on the output. Capacitors with a tolerance of 10% or better are recommended for impedance matching and improved CMRR and PSRR.

PCB LAYOUT GUIDELINES

As output power increases, interconnect resistance (PCB traces and wires) between the amplifier, load, and power supply create a voltage drop. The voltage loss due to the traces between the LM48901 and the load results in lower output power and decreased efficiency. Higher trace resistance between the supply and the LM48901 has the same effect as a poorly regulated supply, increasing ripple on the supply line, and reducing peak output power. The effects of residual trace resistance increases as output current increases due to higher output power, decreased load impedance or both. To maintain the highest output voltage swing and corresponding peak output power, the PCB traces that connect the output pins to the load and the supply pins to the power supply should be as wide as possible to minimize trace resistance.

The use of power and ground planes will give the best THD+N performance. In addition to reducing trace resistance, the use of power planes creates parasitic capacitors that help to filter the power supply line.

The inductive nature of the transducer load can also result in overshoot on one of both edges, clamped by the parasitic diodes to GND and V_{DD} in each case. From an EMI standpoint, this is an aggressive waveform that can radiate or conduct to other components in the system and cause interference. It is essential to keep the power and output traces short and well shielded if possible. Use of ground planes beads and micro-strip layout techniques are all useful in preventing unwanted interference.

As the distance from the LM48901 and the speaker increases, the amount of EMI radiation increases due to the output wires or traces acting as antennas become more efficient with length. Ferrite chip inductors places close to the LM48901 outputs may be needed to reduce EMI radiation.

Revision History

| Rev | Date | Description |
|------|----------|---|
| 1.0 | 10/31/11 | Initial Web released. |
| 1.01 | 12/02/11 | Fixed a typo (LM488901 to LM48901) on page 45. |
| 1.02 | 12/12/11 | Added two sections “Modulator Power Supply” and Clock Requirements. |
| 1.03 | 12/16/11 | Changed National to Texas Instruments. |

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish | MSL Peak Temp (3) | Op Temp (°C) | Top-Side Markings (4) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|-------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| LM48901RL/NOPB | ACTIVE | DSBGA | YPG | 36 | 250 | Green (RoHS & no Sb/Br) | SNAG | Level-1-260C-UNLIM | -40 to 85 | GO2 | Samples |
| LM48901RLX/NOPB | ACTIVE | DSBGA | YPG | 36 | 1000 | Green (RoHS & no Sb/Br) | SNAG | Level-1-260C-UNLIM | -40 to 85 | GO2 | Samples |
| LM48901SQ/NOPB | ACTIVE | WQFN | RTV | 32 | 1000 | Green (RoHS & no Sb/Br) | CU SN | Level-1-260C-UNLIM | -40 to 85 | L48901 | Samples |
| LM48901SQE/NOPB | ACTIVE | WQFN | RTV | 32 | 250 | Green (RoHS & no Sb/Br) | CU SN | Level-1-260C-UNLIM | -40 to 85 | L48901 | Samples |
| LM48901SQX/NOPB | ACTIVE | WQFN | RTV | 32 | 4500 | Green (RoHS & no Sb/Br) | CU SN | Level-1-260C-UNLIM | -40 to 85 | L48901 | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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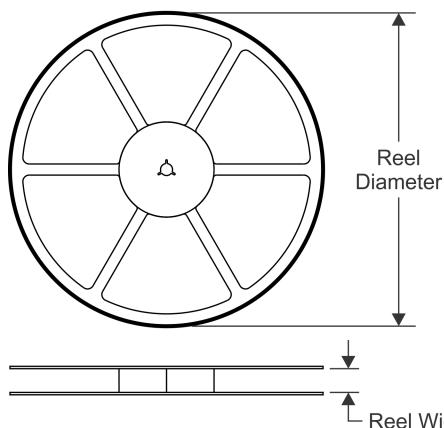
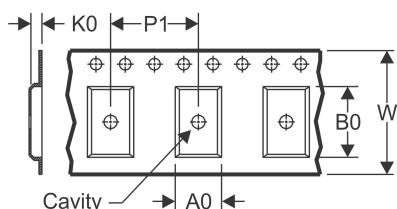


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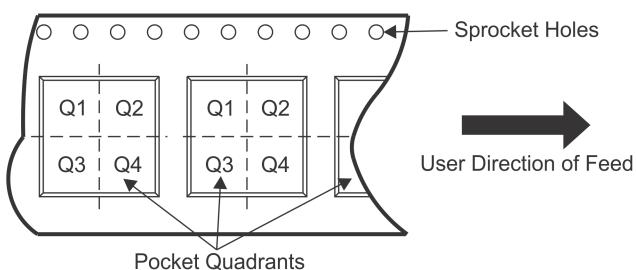
PACKAGE OPTION ADDENDUM

11-Apr-2013

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

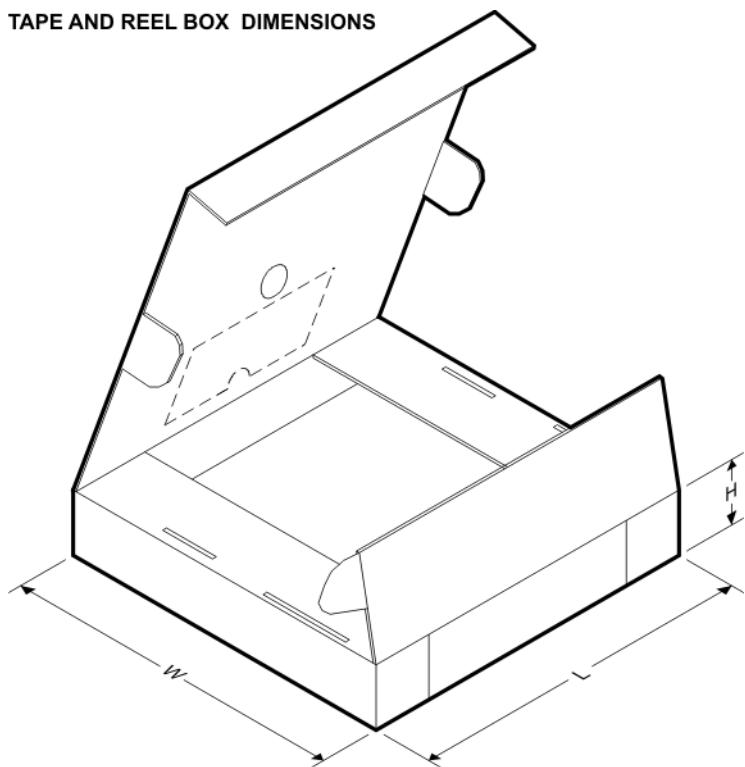
TAPE AND REEL INFORMATION
REEL DIMENSIONS

TAPE DIMENSIONS


| | |
|----|---|
| A0 | Dimension designed to accommodate the component width |
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LM48901RL/NOPB | DSBGA | YPG | 36 | 250 | 178.0 | 12.4 | 3.43 | 3.59 | 0.76 | 8.0 | 12.0 | Q1 |
| LM48901RLX/NOPB | DSBGA | YPG | 36 | 1000 | 178.0 | 12.4 | 3.43 | 3.59 | 0.76 | 8.0 | 12.0 | Q1 |
| LM48901SQ/NOPB | WQFN | RTV | 32 | 1000 | 178.0 | 12.4 | 5.3 | 5.3 | 1.3 | 8.0 | 12.0 | Q1 |
| LM48901SQE/NOPB | WQFN | RTV | 32 | 250 | 178.0 | 12.4 | 5.3 | 5.3 | 1.3 | 8.0 | 12.0 | Q1 |
| LM48901SQX/NOPB | WQFN | RTV | 32 | 4500 | 330.0 | 12.4 | 5.3 | 5.3 | 1.3 | 8.0 | 12.0 | Q1 |

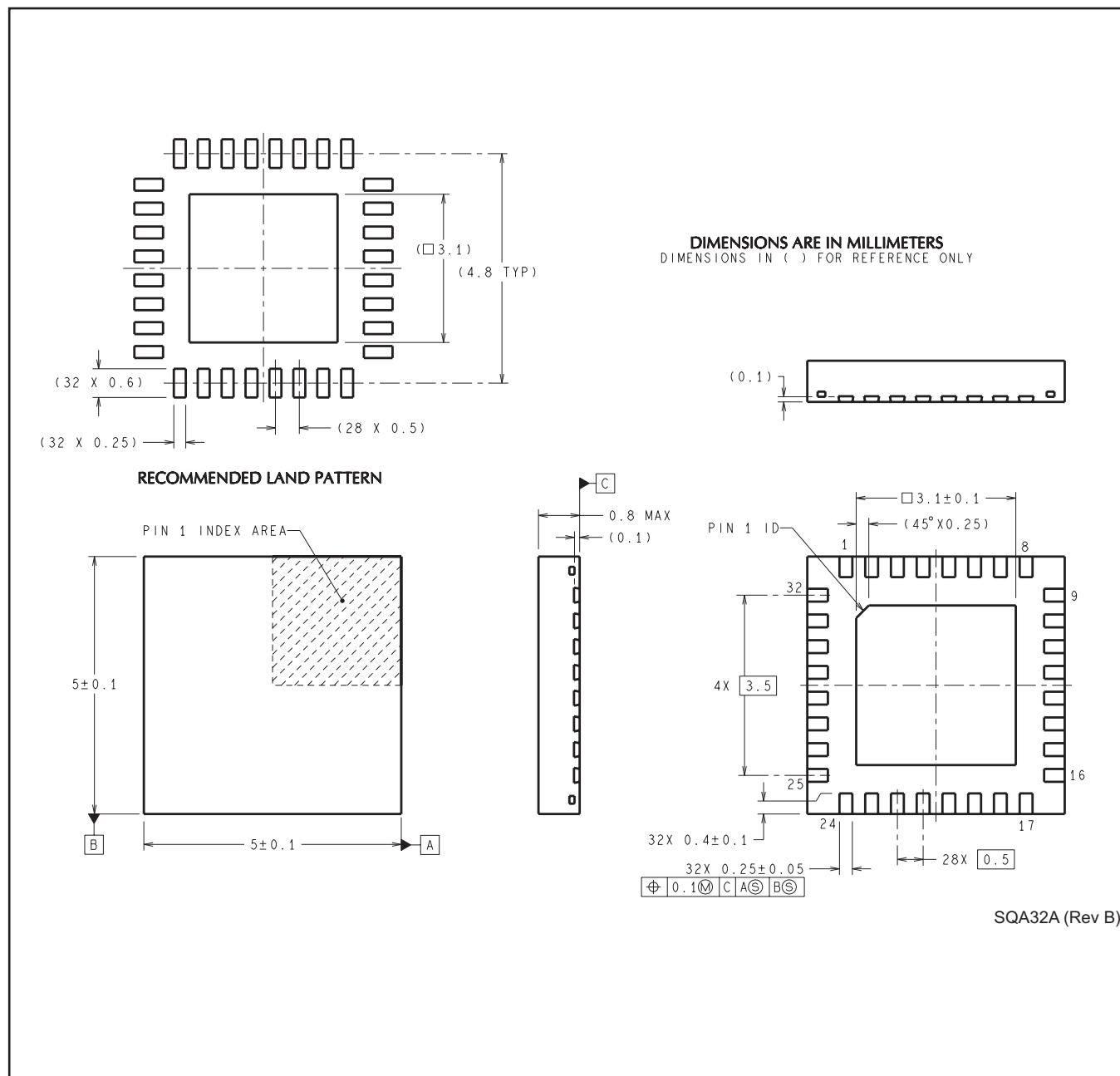
TAPE AND REEL BOX DIMENSIONS


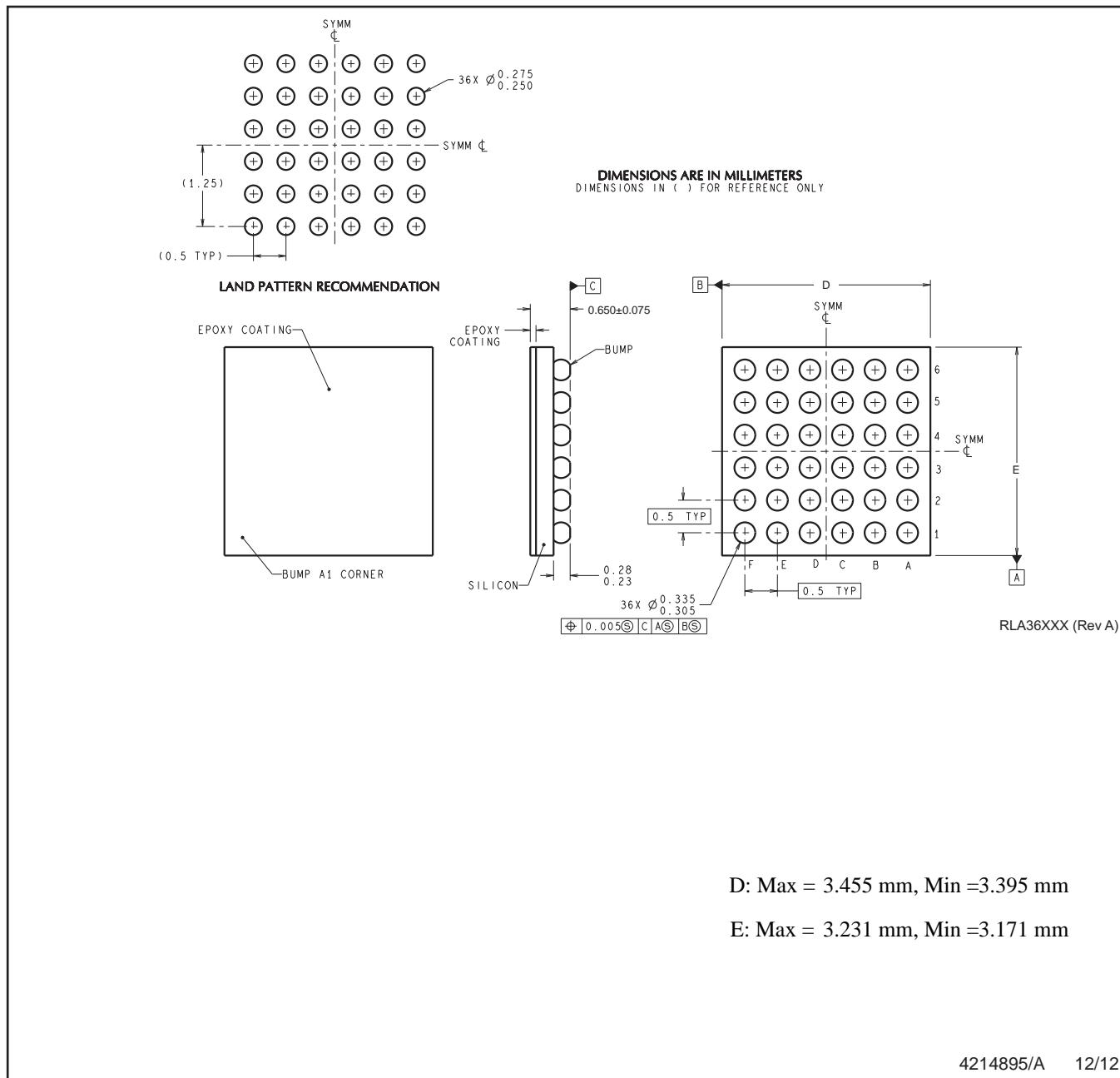
*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LM48901RL/NOPB | DSBGA | YPG | 36 | 250 | 210.0 | 185.0 | 35.0 |
| LM48901RLX/NOPB | DSBGA | YPG | 36 | 1000 | 210.0 | 185.0 | 35.0 |
| LM48901SQ/NOPB | WQFN | RTV | 32 | 1000 | 210.0 | 185.0 | 35.0 |
| LM48901SQE/NOPB | WQFN | RTV | 32 | 250 | 210.0 | 185.0 | 35.0 |
| LM48901SQX/NOPB | WQFN | RTV | 32 | 4500 | 367.0 | 367.0 | 35.0 |

MECHANICAL DATA

RTV0032A





NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
B. This drawing is subject to change without notice.

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